

# Micropower, 3-Axis, $\pm 200 g$ Digital Output, MEMS

Data Sheet ADXL372

#### **FEATURES**

±200 g measurement range
200 Hz to 3200 Hz user selectable bandwidth with 4-pole
antialiasing filter
Selectable oversampling ratio
Adjustable high-pass filter
Ultralow power

Power can be derived from a coin cell battery 22  $\mu$ A at 3200 Hz ODR, 2.5 V supply Low power, wake-up mode for low g activity detection 1.4  $\mu$ A instant on mode with adjustable threshold <0.1  $\mu$ A standby mode

Built in features for system level power savings
Autonomous interrupt processing without processor
intervention

Deep embedded FIFO to minimize host processor load
Ultralow power event monitoring detects impacts and wakes
up fast enough to capture the transient events
Ability to capture and store peak acceleration values of

Adjustable, low *g* threshold activity and inactivity detection Wide supply range: 1.6 V to 3.5 V

Acceleration sample synchronization via external trigger SPI digital interface and limited I<sup>2</sup>C interface format support 12-bit output at 100 mg/LSB scale factor Wide temperature range: -40°C to +105°C Small, thin, 3 mm × 3.25 mm × 1.06 mm package

#### **APPLICATIONS**

Impact and shock detection
Asset health assessment
Portable Internet of Things (IoT) edge nodes
Concussion and head trauma detection

#### **GENERAL DESCRIPTION**

The ADXL372 is an ultralow power, 3-axis,  $\pm 200$  g MEMS accelerometer that consumes 22  $\mu A$  at a 3200 Hz output data rate (ODR). The ADXL372 does not power cycle its front end to achieve its low power operation and therefore does not run the risk of aliasing the output of the sensor.

In addition to its ultralow power consumption, the ADXL372 has many features to enable impact detection while providing system level power reduction. The device includes a deep multimode output first in, first out (FIFO), several activity detection modes, and a method for capturing only the peak acceleration of over threshold events.

Two additional lower power modes with interrupt driven, wake-up features are available for monitoring motion during periods of inactivity. In wake-up mode, acceleration data can be averaged to obtain a low enough output noise to trigger on low g thresholds. In instant on mode, the ADXL372 consumes 1.4  $\mu$ A while continuously monitoring the environment for impacts. When an impact event that exceeds the internally set threshold is detected, the device switches to normal operating mode fast enough to record the event.

High *g* applications tend to experience acceleration content over a wide range of frequencies. The ADXL372 includes a 4-pole low-pass antialiasing filter to attenuate out of band signals that are common in high *g* applications. The ADXL372 also incorporates a high-pass filter to eliminate initial and slow changing errors, such as ambient temperature drift.

The ADXL372 provides 12-bit output data at 100 mg/LSB scale factor. The user can access configuration and data registers via the serial peripheral interface (SPI) or limited  $I^2C$  protocol. The ADXL372 operates over a wide supply voltage range and is available in a 3 mm  $\times$  3.25 mm  $\times$  1.06 mm package.

Multifunction pin names may be referenced by their relevant function only.

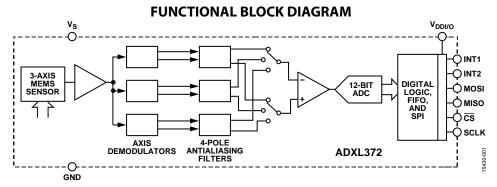


Figure 1.

Rev. B

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# **TABLE OF CONTENTS**

Features1	Multibyte Transfers	26
Applications1	Invalid Addresses and Address Folding	27
General Description1	Register Map	30
Functional Block Diagram1		
Revision History 3	Analog Devices ID Register	32
Specifications4	Analog Devices MEMS ID Register	32
Absolute Maximum Ratings6	Device ID Register	32
Thermal Resistance6	Product Revision ID Register	32
Recommended Soldering Profile6	Status Register	33
ESD Caution6	Activity Status Register	33
Pin Configuration and Function Descriptions7	FIFO Entries Register, MSB	34
Typical Performance Characteristics 8	FIFO Entries Register, LSB	34
Theory of Operation13	X-Axis Data Register, MSB	34
Mechanical Device Operation13	X-Axis Data Register, LSB	34
Operating Modes13	WALL DA DA LA MOD	35
Bandwidth	WALL DA DA LA TOD	35
Power/Noise Trade-Off14	Z-Axis Data Register, MSB	35
Power Savings	Z-Axis Data Register, LSB	35
Autonomous Event Detection16	Highest Peak Data Registers	36
Activity and Inactivity16	X-Axis Highest Peak Data Register, MSB	36
Motion Warning	V Avia Highart Deals Data Degister I CD	36
Impact Detection Features19	V Arris Highart Dool: Data Dogiston MCD	36
Wide Bandwidth19	WASHIEL ON LOUD ON THE LOD	37
Instant On Impact Detection	Z-Axis Highest Peak Data Register, MSB	37
Capturing Impact Events	7 Asia High ant Dark Date Darietan ICD	37
FIFO	Off the Post	38
Benefits of the FIFO	X-Axis Offset Trim Register, LSB	38
Using the FIFO	Y-Axis Offset Trim Register, LSB	38
Retrieving Data from FIFO21	Z-Axis Offset Trim Register, LSB	38
Interrupts	V Assis Astissites Thursdall Desister MCD	39
Interrupt Pins	V Axis of Activity Threshold Dogister ICP	39
Types of Interrupts	V Asia Astisita Thurshall Desister MCD	39
Additional Features24	V Arris of Astirity Throshold Dogistor ICD	40
Using an External Clock24	Z-Axis Activity Threshold Register, MSB	40
Synchronized Data Sampling24	7 Anima CARC to Thomas 11 Decision I CD	40
Self Test	Activity Time Degister	41
User Register Protection	V Ania Inantinita Thumbald Demistra MCD	41
User Offset Trims	TALL OF THE LIP CALLED	42
Serial Communications26	V Asia In activity Through ald Designary MCD	42
Serial Interface	VA to Cloud; to Though 11 Decision ICD	43

Z-Axis Inactivity Threshold Register, MSB43
Z-Axis of Inactivity Threshold Register, LSB43
Inactivity Time Registers44
Inactivity Timer Register, MSB44
Inactivity Timer Register, LSB44
X-Axis Motion Warning Threshold Register, MSB45
X-Axis of Motion Warning Notification Register, LSB45
Y-Axis Motion Warning Notification Threshold Register, MSB46
Y-Axis of Motion Warning Notification Register, LSB46
Z-Axis Motion Warning Notification Threshold Register, MSB46
Z-Axis Motion Warning Notification Register, LSB47
High-Pass Filter Settings Register47
FIFO Samples Register48
FIFO Control Register48
Interrupt Pin Function Map Registers49
REVISION HISTORY
8/2018—Rev. A to Rev. B
Changes to Figure 3419
Changes to I <sup>2</sup> C Protocol Section
Added Note 1, Table 14; Renumbered Sequentially31
12/2017—Rev. 0 to Rev. A
Changes to Turn-On Time, Measurement Mode Instruction to
Valid Data Parameter; Table 15
Changes to Instant On Impact Detection Section19
Changes to Address: 0x3A, Reset: 0x00, Name: FIFO_CTL
Section

3/2017—Revision 0: Initial Version

	IN 12 Function Map Register	.50
	External Timing Control Register	.50
	Measurement Control Register	.51
	Power Control Register	.52
	Self Test Register	.53
	RESET (Clears) Register, Part in Standby Mode	.53
	FIFO Access Register	.53
A	pplications Information	.54
	Application Examples	.54
	Operation at Voltages Other Than 2.5 V	.54
	Operation at Temperatures Other Than Ambient	.54
	Mechanical Considerations for Mounting	.54
	Axes of Acceleration Sensitivity	.55
	Layout and Design Recommendations	.55
О	outline Dimensions	.56
	Ordering Guide	.56

# **SPECIFICATIONS**

 $T_A = 25$ °C,  $V_S = 2.5$  V,  $V_{DDI/O} = 2.5$  V, 3200 Hz ODR, 1600 Hz bandwidth, acceleration = 0 g, default register settings, unless otherwise noted. All minimum and maximum specifications are guaranteed. Typical specifications may not be guaranteed.

Table 1.

Parameter	Test Conditions/Comments	Min	Тур	Max	Unit
SENSOR INPUT	Each axis				
Measurement Range			±200		g
Nonlinearity	Percentage of full scale		±0.5		%
Sensor Resonant Frequency			16		kHz
Cross Axis Sensitivity <sup>1</sup>			±2.5		%
OUTPUT RESOLUTION	Each axis				
All Operating Modes			12		Bits
SCALE FACTOR	Each axis				
Scale Factor Calibration Error				±10	%
Scale Factor at X <sub>OUT</sub> , Y <sub>OUT</sub> , Z <sub>OUT</sub>	Expressed in mg/LSB		100		mg/LSB
	Expressed in LSB/ $g$		10		LSB/g
Scale Factor Change Due to Temperature <sup>2</sup>			0.1		%/°C
0 g OFFSET	Each axis				
0 g Output	Хоит, Үоит, Zоит				
	At $V_S = 2.5 \text{ V}$	-3	±1	+3	g
	$1.6V \leq V_S \leq 3.5V$	-7	±1	+7	g
0 g Offset vs. Temperature <sup>2</sup>					
Normal Operation	Хоит, Уоит, Zоит		±50		m <i>g/</i> °C
Low Noise Mode	Хоит, Үоит, Zоит		±35		m <i>g/</i> °C
NOISE PERFORMANCE					
RMS Noise	Each axis				
Normal Operation			3.5		LSB
Low Noise Mode			3		LSB
BANDWIDTH	User selectable				
ODR		400		6400	Hz
High-Pass Filter, −3 dB Corner <sup>3</sup>		0.24		30.48	Hz
Low-Pass (Antialiasing) Filter, –3 dB Corner <sup>4</sup>	4-pole low-pass filter	200		ODR/2	Hz
POWER SUPPLY					
Operating Voltage Range (V <sub>s</sub> )		1.6	2.5	3.5	V
Input/Output Voltage Range (VDDI/O)		1.6	2.5	$V_{S}$	V
Supply Current					
Measurement Mode	3200 Hz ODR				
Normal Operation			22		μΑ
Low Noise Mode			33		μΑ
Instant On Mode			1.4		μΑ
Wake-Up Mode	Varies with wake-up rate				
	At slowest wake-up rate		0.77		μΑ
Standby			<0.1		μΑ
Power Supply Rejection Ratio (PSRR)	$C_S = 1.1 \mu F$ , $C_{IO} = 1.1 \mu F$ , input is 100 mV sine wave on $V_S$				
Input Frequency					
100 Hz to 1 kHz			-20		dB
1 kHz to 250 kHz			-17		dB

Parameter	Test Conditions/Comments	Min	Тур	Max	Unit
Turn-On Time	3200 Hz ODR				
Power-Up to Standby	$C_S = 1.1 \mu F$ , $C_{IO} = 1.1 \mu F$		5		ms
Measurement Mode Instruction to Valid Data	Filter settle bit = 1		16		ms
	Filter settle bit = 0		370		ms
Instant On ULP Monitoring to Full Bandwidth Data			1		ms
ENVIRONMENTAL TEMPERATURE					
Operating Temperature Range		-40		+105	°C

 $<sup>^1</sup>$  Cross axis sensitivity is defined as coupling between any two axes.  $^2$  –40°C to +25°C or +25°C to +105°C.  $^3$  This parameter has an available corner frequency scale with the ODR setting.  $^4$  Bandwidth and ODR are set independent of each other.

### **ABSOLUTE MAXIMUM RATINGS**

Table 2.

Parameter	Rating
Acceleration	
Any Axis, Unpowered	10000 <i>g</i>
Any Axis, Powered	10000 <i>g</i>
$V_S$	-0.3 V to +3.6 V
$V_{\text{DDI/O}}$	-0.3 V to +3.6 V
All Other Pins	$-0.3  V$ to $V_S$
Output Short-Circuit Duration (Any Pin to Ground)	Indefinite
ESD, Human Body Model (HBM)	2000 V
Temperature Range (Storage)	−50°C to +150°C

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

#### THERMAL RESISTANCE

Thermal performance is directly linked to printed circuit board (PCB) design and operating environment. Careful attention to PCB thermal design is required.

Table 3.

Package Type <sup>1</sup>	$\theta_{JA}$	θ,ς	Unit	Device Weight
CC-16-4	150	85	°C/W	18 m <i>g</i>

<sup>&</sup>lt;sup>1</sup> Thermal impedance simulated values are based on a JEDEC 2S2P thermal test board with four thermal vias. See JEDEC JESD51.

#### **RECOMMENDED SOLDERING PROFILE**

Figure 2 and Table 4 provide details about the recommended soldering profile.

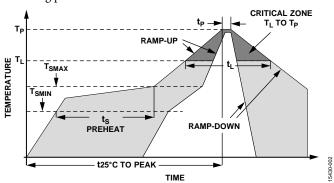


Figure 2. Recommended Soldering Profile

**Table 4. Recommended Soldering Profile** 

	Condition		
Profile Feature	Sn63/Pb37	Pb-Free	
Average Ramp Rate (T <sub>L</sub> to T <sub>P</sub> )	3°C/sec max	3°C/sec max	
Preheat			
Minimum Temperature (T <sub>SMIN</sub> )	100°C	150°C	
Maximum Temperature (T <sub>SMAX</sub> )	150°C	200°C	
Time (T <sub>SMIN</sub> to T <sub>SMAX</sub> ) (t <sub>s</sub> )	60 sec to	60 sec to	
	120 sec	180 sec	
$T_{SMAX}$ to $T_L$			
Ramp-Up Rate	3°C/sec max	3°C/sec max	
Time Maintained Above Liquidous (T∟)			
Liquidous Temperature (T <sub>L</sub> )	183°C	217°C	
Time (t∟)	60 sec to	60 sec to	
	150 sec	150 sec	
Peak Temperature (T <sub>P</sub> )	240 + 0/-5°C	260 + 0/-5°C	
Time Within 5°C of Actual Peak Temperature (t <sub>P</sub> )	10 sec to 30 sec	20 sec to 40 sec	
Ramp-Down Rate	6°C/sec max	6°C/sec max	
Time 25°C to Peak Temperature	6 minutes max	8 minutes max	

#### **ESD CAUTION**



**ESD** (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

# PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

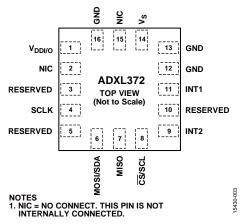


Figure 3. Pin Configuration (Top View)

**Table 5. Pin Function Descriptions** 

Pin No.	Mnemonic	Description
1	V <sub>DDI/O</sub>	Supply Voltage for Digital Input/Output.
2	NIC	No Connect. This pin is not internally connected.
3	RESERVED	Reserved. This pin may be left unconnected or connected to GND.
4	SCLK	SPI Serial Communications Clock.
5	RESERVED	Reserved. This pin may be left unconnected or connected to GND.
6	MOSI/SDA	SPI Master Output, Slave Input (MOSI). I <sup>2</sup> C Serial Data (SDA).
7	MISO	SPI Master Input, Slave Output.
8	CS/SCL	SPI Chip Select (CS). I <sup>2</sup> C Serial Communications Clock (SCL).
9	INT2	Interrupt 2 Output. This pin also serves as an input for synchronized sampling.
10	RESERVED	Reserved. This pin may be left unconnected or connected to GND.
11	INT1	Interrupt 1 Output. This pin also serves as an input for external clocking.
12	GND	Ground. This pin must be connected to ground.
13	GND	Ground. This pin must be connected to ground.
14	Vs	Supply Voltage.
15	NIC	No Connect. This pin is not internally connected.
16	GND	Ground. This pin must be connected to ground.

### TYPICAL PERFORMANCE CHARACTERISTICS

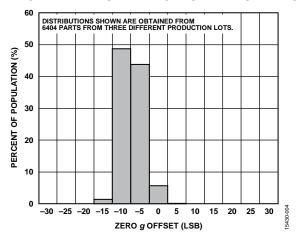


Figure 4. X-Axis Zero g Offset at 25°C,  $V_S = 2.5 \text{ V}$ 

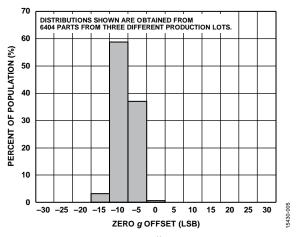


Figure 5. Y-Axis Zero g Offset at 25°C,  $V_S = 2.5 V$ 

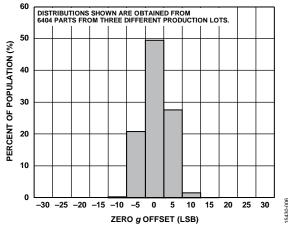


Figure 6. Z-Axis Zero g Offset at 25°C,  $V_S = 2.5 V$ 

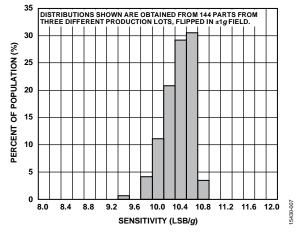


Figure 7. X-Axis Sensitivity at 25°C,  $V_S = 2.5 \text{ V}$ 

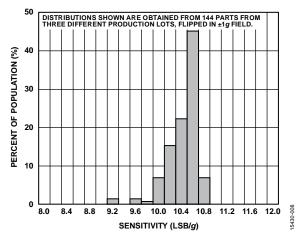


Figure 8. Y-Axis Sensitivity at 25°C,  $V_S = 2.5 \text{ V}$ 

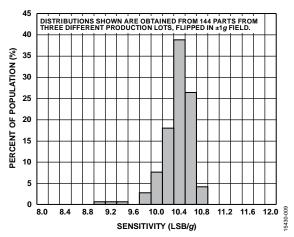


Figure 9. Z-Axis Sensitivity at 25°C,  $V_S = 2.5 \text{ V}$ 

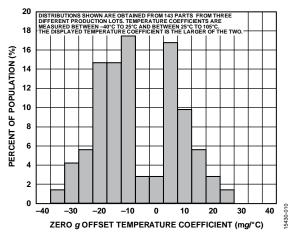


Figure 10. X-Axis Zero g Offset Temperature Coefficient,  $V_S = 2.5 \text{ V}$ 

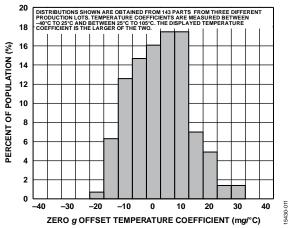


Figure 11. Y-Axis Zero g Offset Temperature Coefficient,  $V_S = 2.5 V$ 

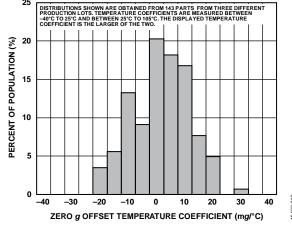


Figure 12. Z-Axis Zero g Offset Temperature Coefficient,  $V_S = 2.5 \text{ V}$ 

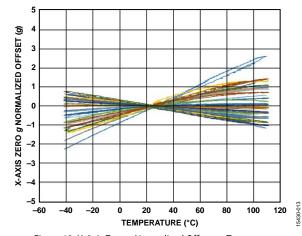


Figure 13. X-Axis Zero g Normalized Offset vs. Temperature, 36 Parts Soldered to PCB, ODR = 3200 Hz

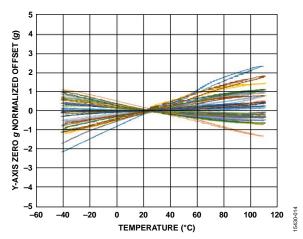


Figure 14. Y-Axis Zero g Normalized Offset vs. Temperature, 36 Parts Soldered to PCB, ODR = 3200 Hz

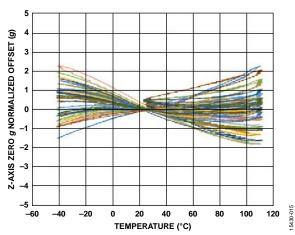


Figure 15. Z-Axis Zero g Normalized Offset vs. Temperature, 36 Parts Soldered to PCB, ODR = 3200 Hz

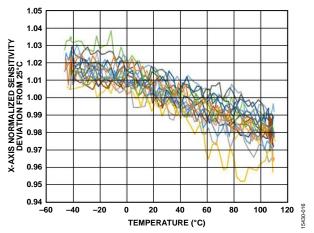


Figure 16. X-Axis Normalized Sensitivity Deviation from 25°C vs. Temperature, 18 Parts Soldered to PCB, ODR = 3200 Hz

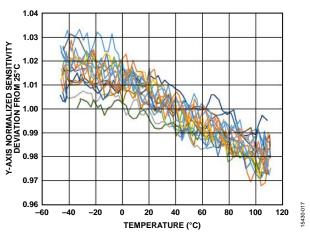


Figure 17. Y-Axis Normalized Sensitivity Deviation from 25°C vs. Temperature, 17 Parts Soldered to PCB, ODR = 3200 Hz

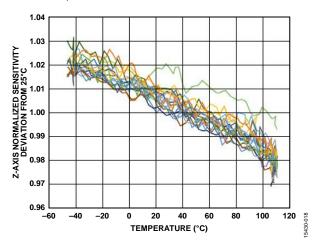


Figure 18. Z-Axis Normalized Sensitivity Deviation from 25°C vs. Temperature, 18 Parts Soldered to PCB, ODR = 3200 Hz

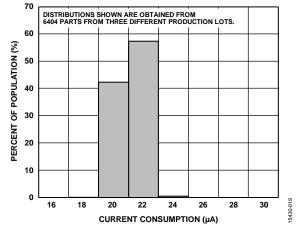


Figure 19. Current Consumption at 25°C, Normal Mode, 3200 Hz Output Data Rate,  $V_S = 2.5 \text{ V}$ 

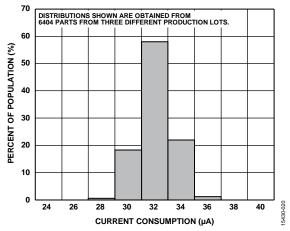


Figure 20. Current Consumption at 25°C, Low Noise Mode, 3200 Hz Output Data Rate,  $V_S = 2.5 \text{ V}$ 

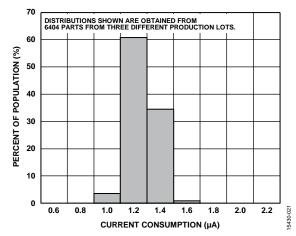


Figure 21. Current Consumption at 25°C, Instant On Mode,  $V_S = 2.5 \text{ V}$ 

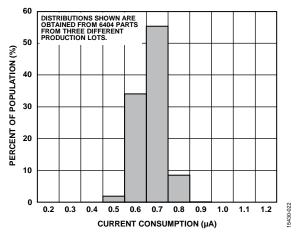


Figure 22. Current Consumption at 25°C, Wake-Up Mode,  $V_S = 2.5 \text{ V}$ 

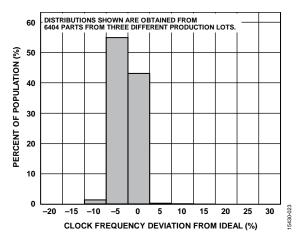


Figure 23. Clock Frequency Deviation from Ideal at 25°C, ODR = 3200 Hz,  $V_S$  = 2.5  $V_S$ 

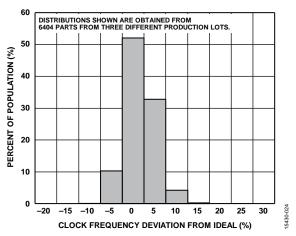


Figure 24. Clock Frequency Deviation from Ideal at 25°C, ODR = 6400Hz,  $V_S$  = 2.5 V

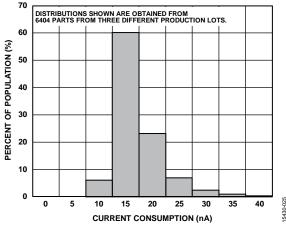


Figure 25. Current Consumption at 25°C, Standby Mode,  $V_S = 2.5 \text{ V}$ 

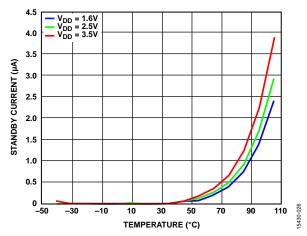


Figure 26. Standby Current vs. Temperature

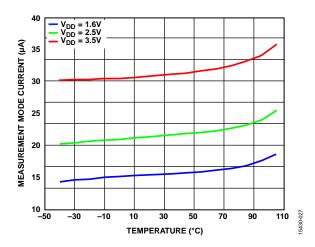


Figure 27. Measurement Mode Current vs. Temperature

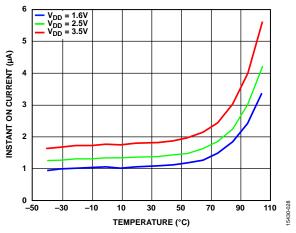


Figure 28. Instant On Current vs. Temperature

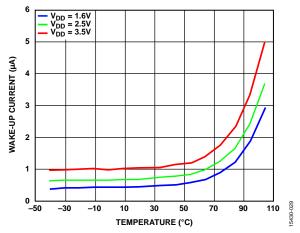


Figure 29. Wake-Up Current vs. Temperature

#### THEORY OF OPERATION

The ADXL372 is a complete 3-axis acceleration measurement system that operates at extremely low power levels. Acceleration is reported digitally, and the device communicates via the SPI and I<sup>2</sup>C protocols. Built in digital logic enables autonomous operation and implements functions that enhance system level power savings.

#### **MECHANICAL DEVICE OPERATION**

The moving component of the sensor is a polysilicon surface micromachined structure built on top of a silicon wafer. Polysilicon springs suspend the structure over the surface of the wafer and provide a resistance against acceleration forces.

Deflection of the structure is measured using differential capacitors that consist of independent fixed plates and plates attached to the moving mass. Acceleration deflects the structure and unbalances the differential capacitor, resulting in a sensor output whose amplitude is proportional to acceleration. Phase sensitive demodulation determines the magnitude and polarity of the acceleration.

#### **OPERATING MODES**

The ADXL372 has three operating modes: measurement mode for continuous, wide bandwidth sensing; an instant on mode for low power impact detection; and wake-up mode for limited bandwidth low *g* activity detection. Measurement can be suspended by placing the device in standby mode.

#### **Measurement Mode**

Measurement mode is the default operating mode of the ADXL372. In this mode, acceleration data is read continuously, and the accelerometer consumes 22  $\mu A$  (typical) at an ODR of 3200 Hz using a 2.5 V supply. Actual current consumption is dependent on the ODR chosen. All features described in this data sheet are available when operating the ADXL372 in this mode.

#### Instant On Mode

Instant on mode enables extremely low power impact detection. In this mode, the accelerometer constantly monitors the environment while consuming a very low current of 1.4  $\mu A$  (typical). When an event that exceeds an internal threshold is detected, the device switches into measurement mode to record the event. The target default threshold is 10 g to 15 g, but it can vary. A register option allows the threshold to be increased to a target of 30 g to 40 g if the default threshold is too low.

To save power, no new digital acceleration data is made available until the accelerometer switches into normal operation. However, all registers have normal read/write functionality.

#### Wake-Up Mode

Wake-up mode is ideal for simple detection of the presence or absence of motion at an extremely low power consumption. Wake-up mode is particularly useful for the implementation of a low *g* motion activated on/off switch, allowing the rest of the system to be powered down until sustained activity is detected.

In wake-up mode, the device is powered down for a duration of time equal to the wake-up timer, set by the WAKEUP\_RATE bits in the TIMING register, and then turns on for a duration equal to the filter settling time (see the Filter Settling Time section). The current drawn in this mode is determined by both these parameters.

Table 6. Wake-Up Current in  $\mu A$  at Different Wake-Up Timer and Filter Settings

	Filter Settling Time		
Wake-Up Timer (ms)	16 ms	370 ms	
52	5.8 μA	19.4 μΑ	
104	3.6 µA	17.3 μΑ	
208	2.3 μΑ	14.4 μΑ	
512	1.4 μΑ	9.7 μΑ	
2048	0.91 μΑ	4 μΑ	
4096	0.83 μΑ	2.5 μΑ	
8192	0.79 μΑ	1.7 μΑ	
24576	0.77 μΑ	1.1 μΑ	

If motion is detected, the accelerometer can respond autonomously in several ways, depending on the device configuration, such as the following:

- Switch into full bandwidth measurement mode.
- Signal an interrupt to a microcontroller.
- Wake up downstream circuitry.

While in wake-up mode, all registers and the FIFO have normal read/write functionality, and real-time data can be read from the data registers at the reduced wake-up rate. However, no new data is stored in the FIFO during wake-up mode, and there are no interrupts available in wake-up mode.

#### Standby

Placing the ADXL372 in standby mode suspends measurement and reduces current consumption to less than 100 nA. All interrupts are cleared, and no new interrupts are generated. The ADXL372 powers up in standby mode with all sensor functions turned off.

#### **BANDWIDTH**

#### **Low-Pass Antialiasing Filter**

High *g* events often include acceleration content over a wide range of frequencies. The analog-to-digital converter (ADC) of the ADXL372 samples the input acceleration at the user selected ODR. In the absence of antialiasing filters, input signals whose frequency is more than half the ODR alias or that fold into the measurement bandwidth can lead to inaccurate measurements. To mitigate this inaccuracy, a four-pole, low-pass filter is provided at the input of the ADC. The filter bandwidth is user selectable, and the default bandwidth is 200 Hz. The maximum bandwidth is constrained to at most half of the ODR, to ensure that the Nyquist criteria is not violated.

#### **High-Pass Filter**

The ADXL372 offers a one-pole, high-pass filter with a user selectable –3 dB frequency. Applications that do not require dc acceleration measurements can use the high-pass filter to minimize constant or slow varying offset errors including initial bias, bias drift due to temperature, and bias drift due to supply voltage.

The high-pass filter is a first-order infinite impulse response (IIR) filter. Table 7 lists the available -3 dB frequencies, which are user selectable and dependent on the output data rate. The high-pass and low-pass filters can be used simultaneously to set up a band-pass option.

Table 7. High-Pass Filter -3 dB Corner Frequencies

	ODR (Hz)				
Setting	6400	3200	1600	800	400
00	30.48	15.24	7.61	3.81	1.9
01	15.58	7.79	3.89	1.94	0.97
10	7.88	3.94	1.97	0.98	0.49
11	3.96	1.98	0.99	0.49	0.24

#### Filter Settling Time

After entering measurement mode, the first output value does not appear until after the filter settling time has passed. This time is selectable using the FILTER\_SETTLE bit in the POWER\_CTL register. The recommended (and default) settling time to acquire valid data when using either the high-pass filter or the low-pass activity detect filter is 370 ms. The filter settling time of 16 ms is ideal for when both the high-pass filter and low-pass activity detect filter are disabled.

#### Selectable ODR

The ADXL372 can report acceleration data at 400 Hz, 800 Hz, 1600 Hz, 3200 Hz, or 6400 Hz. The ODR is user selectable and the default is 400 Hz. In the event that the user selects an antialiasing filter bandwidth greater than half the ODR, the device defaults the bandwidth to half the ODR. Increasing or decreasing the ODR increases or decreases the current consumption accordingly, as shown in Figure 30.

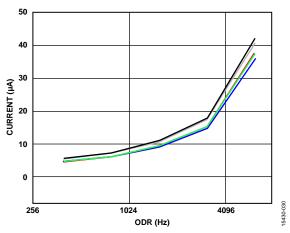


Figure 30. Measurement Mode Current vs. ODR for Five Parts

#### **POWER/NOISE TRADE-OFF**

The noise performance of the ADXL372 in normal operation, typically 3.5 LSB rms at 3200 Hz ODR and 1600 Hz bandwidth, is adequate for most applications, depending on bandwidth and the desired resolution. For cases where lower noise is needed, the ADXL372 provides a lower noise operating mode that trades reduced noise for a somewhat higher current consumption. In all cases, operating at a higher bandwidth setting increases the rms noise and operating with a lower bandwidth decreases the noise. Table 8 lists the current consumption and noise densities obtained for normal operation and the lower noise mode at a typical 2.5 V supply.

Operating the ADXL372 at a higher supply voltage also decreases noise. Table 9 lists the current consumption and noise densities obtained for normal operation and the lower noise mode at the highest recommended supply, 3.5 V.

Table 8. Noise and Current Consumption for  $V_S = 2.5 \text{ V}$ 

Mode	Typical RMS Noise (LSB)	Typical Current Consumption (μA)
Normal Operation <sup>1</sup>	3.5	22
Low Noise <sup>1</sup>	3	33

 $<sup>^1\,</sup>V_S$  = 2.5 V, ODR = 3200 Hz, and bandwidth = 1600 Hz.

Table 9. Noise and Current Consumption for  $V_S = 3.5 \text{ V}$ 

Mode	Typical RMS Noise (LSB)	Typical Current Consumption (μA)
Normal Operation <sup>1</sup>	3	32
Low Noise <sup>1</sup>	2.5	44

 $<sup>^{1}</sup>$  V<sub>S</sub> = 3.5 V, ODR = 3200 Hz, and bandwidth = 1600 Hz.

#### **POWER SAVINGS**

The digital interface of the ADXL372 is implemented with system level power savings in mind. The following features enhance power savings:

- Burst reads and writes reduce the number of SPI communication cycles required to configure the device and retrieve data.
- Concurrent operation of activity and inactivity detection enables set it and forget it operation. Loop modes further reduce communications power by enabling the clearing of interrupts without processor intervention.

 The FIFO is implemented such that consecutive samples can be read continuously via a multibyte read of unlimited length; thus, one FIFO read instruction can clear the entire contents of the FIFO. The ADXL372 FIFO construction also allows the use of direct memory access (DMA) to read the FIFO contents.

# AUTONOMOUS EVENT DETECTION ACTIVITY AND INACTIVITY

The ADXL372 features built in logic that detects activity (defined as acceleration above a user set threshold) and inactivity (defined as acceleration below a user set threshold). Activity and inactivity events can be used as triggers to manage the accelerometer operating mode, trigger an interrupt to a host processor, and/or autonomously drive a motion switch.

Detection of an activity or inactivity event is indicated in the STATUS2 register and can be configured to generate an interrupt. In addition, the activity status of the device, that is, whether it is moving or stationary, is indicated by the AWAKE bit, described in the Using the AWAKE Bit section.

Activity and inactivity detection can be used when the accelerometer is in either measurement mode or wake-up mode. However, the activity and inactivity interrupts are not available in wake-up mode because the device is inherently looking for activity in this mode, and any changes to activity or inactivity detection features must be made while the device is in standby mode.

#### **Low-Pass Activity Detect Filter**

The ADXL372 combines high g impact detection and low g movement detection in one device. For low g detection, an internal low-pass filter with a -3 dB corner of approximately 10 Hz averages data to reduce the rms noise, allowing accurate detection of activity or inactivity thresholds as low as 500 mg. For high g impact detection, the low-pass activity detect filter can be turned off through a register setting. When using both the low-pass activity detect filter and the high-pass filter, the user must select a high-pass filter corner that does not exceed 10 Hz; otherwise, activity detection data is severely attenuated.

#### **Activity Detection**

An activity event is detected when acceleration in at least one enabled axis remains above a specified threshold for a specified time. Enabled axes, thresholds, and time are user selected. Each axis has its own activity threshold, but the activity timer is shared among all three axes. When multiple axes are selected, an overthreshold event on any one enabled axis triggers the activity detection.

#### **Referenced and Absolute Configurations**

Activity detection can be configured as referenced or absolute mode for all axes through the ACT\_REF bit in the THRESH\_ ACT\_X\_L register.

When using absolute activity detection, acceleration samples are compared directly to a user set threshold to determine whether motion is present. For example, if a threshold of  $0.5\,g$  is set and the acceleration on the z-axis is  $1\,g$  longer than the user defined activity time, the activity status asserts.

In many applications, it is advantageous for activity detection to be based not on an absolute threshold, but on a deviation from a reference point or orientation. The referenced activity detection is particularly useful because it removes the effect on activity detection of the static 1 *g* imposed by gravity as well as any static offset errors, which can be up to several *g*. In absolute activity detection, when the threshold is set to less than 1 *g*, activity is immediately detected in this case.

In the referenced configuration, activity is detected when acceleration samples are above an internally defined reference by a user defined amount for the user defined amount of time, as described by

Abs(Acceleration - Reference) > Threshold where Abs is the absolute value.

Consequently, activity is detected only when the acceleration has deviated sufficiently from the initial orientation. The default setting for the accelerometer is in absolute mode. After it is placed in referenced mode through the appropriate register setting, the reference for activity detection is calculated as soon as full bandwidth measurement mode is turned on. To reset the reference, it is necessary to put the device back into absolute mode and then back to referenced mode. The new reference is set as soon as the device enters full bandwidth measurement mode again. If using both activity and inactivity detection in referenced mode, both must be set back to absolute mode before the reference can be reset.

#### **Activity Timer**

Ideally, the intent of activity detection is to wake up a system only when motion is intentional, ignoring noise or small, unintentional movements. In addition to being sensitive to low *g* events, the ADXL372 activity detection algorithm is robust in filtering out undesired triggers.

The ADXL372 activity detection functionality includes a timer to filter out unwanted motion and ensure that only sustained motion is recognized as activity. The timer period depends on the ODR selected. At 3200 Hz and below, it is  $\sim$ 6.6 ms; at 6400 Hz, it is  $\sim$ 3.3 ms. For activity detection to trigger, above threshold activity must be sustained for a time equal to the number of activity timer periods specified in the activity time register. For example, a setting of 10 in this register means that above threshold activity must be sustained for 66 ms at 3200 Hz ODR. A register value of zero results in single sample activity detection. The maximum allowable activity time is  $\sim$ 1.68 sec (or 841.5 ms at 6400 Hz ODR). Note that the activity timer is operational in measurement mode only.

#### Activity Detection in Wake-Up Mode

If activity detection is enabled while the device is in wake-up mode, the device uses single sample activity detection, no matter the activity time register setting. If activity is detected, the device automatically returns to full bandwidth measurement mode. However, the activity interrupt is not generated unless the activity time setting is zero. If it is not zero, after entering measurement mode, the interrupt is not generated until the device sees sustained activity for the amount of time given in the activity time register. The awake interrupt automatically goes high upon entering measurement mode if the device is in default mode or autosleep mode. If it is in linked or loop mode (but not autosleep), it is linked to the activity interrupt, which behaves as previously mentioned.

After the device automatically enters measurement mode due to activity detection, if autosleep is not on, it must be placed manually back into wake-up mode.

#### **Inactivity Detection**

An inactivity event is detected when acceleration in all enabled axes remains below a specified threshold for a specified time. Enabled axes, threshold, and time are user selected. Each axis has its own inactivity threshold, but the inactivity timer is shared among all three axes. When multiple axes are selected, all enabled axes must stay under the threshold for the required amount of time to trigger inactivity detection.

#### Referenced and Absolute Configurations

Inactivity detection is also configurable as referenced or absolute through the INACT\_REF bit in the THRESH\_INACT\_X\_L register. When using absolute inactivity detection, acceleration samples are compared directly to a user set threshold for the user set time to determine the absence of motion. Inactivity is detected when enough consecutive samples are all below the threshold.

When using referenced inactivity detection, inactivity is detected when acceleration samples are within a user specified amount from an internally defined reference for a user defined amount of time.

Abs(Acceleration - Reference) < Threshold

Referenced inactivity, like referenced activity, is particularly useful for eliminating the effects of the static acceleration due to gravity, as well as other static offsets. With absolute inactivity, if the inactivity threshold is set lower than 1 g, a device resting motionless may never detect inactivity. With referenced inactivity, the same device under the same configuration detects inactivity. The default setting for the accelerometer is in absolute mode. After it is placed in referenced mode through the appropriate register setting, the reference for inactivity detection is calculated as soon as full bandwidth measurement mode is turned on. To reset the reference, it is necessary to put the device back into absolute mode and then back to referenced mode. The new reference is set as soon as the device enters full bandwidth measurement mode again. If using both inactivity and activity detection in referenced mode, both must be set back to absolute mode before the reference can be reset.

#### **Inactivity Timer**

The ADXL372 inactivity detect functionality includes a timer to allow detection of sustained inactivity. The timer period depends on the ODR selected. At 3200 Hz and below, it is ~26 ms; at 6400 Hz, it is ~13 ms. For inactivity detection to trigger, below threshold inactivity must be sustained for a time equal to the number of inactivity timer periods specified in the inactivity time registers. For example, a setting of 10 in these registers means that below threshold inactivity must be sustained for 260 ms at 3200 Hz ODR. A value of zero in these registers results in single sample, inactivity detection. The maximum allowable inactivity time is ~28.4 minutes at 3200 Hz ODR (or ~14.2 minutes at 6400 Hz ODR).

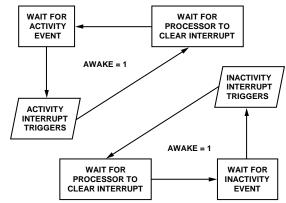
#### **Linking Activity and Inactivity Detection**

When in measurement mode or wake-up mode, the activity and inactivity detection functions can be used concurrently and processed manually by a host processor, or they can be configured to interact in several other ways, such as those that follow.

#### **Default Mode**

In default mode, activity and inactivity detection are both available simultaneously, and all interrupts must be serviced by a host processor; that is, a processor must read each interrupt before it is cleared and can be used again. Refer to the Interrupts section for information on clearing interrupts.

The flowchart in Figure 31 illustrates default mode operation.



NOTES

1. THE AWAKE BIT DEFAULTS TO 1 WHEN ACTIVITY AND INACTIVITY
ARE NOT LINKED.

Figure 31. Flowchart Illustrating Activity and Inactivity Operation in Default Mode

#### Linked Mode

In linked mode, activity and inactivity detection are linked to each other such that only one of the functions is enabled at any given time. As soon as activity is detected, the device is assumed to be moving (or awake) and stops looking for activity; rather, inactivity is expected as the next event. Therefore, only inactivity detection operates.

Similarly, when inactivity is detected, the device is assumed to be stationary (or asleep). Thus, activity is expected as the next event; therefore, only activity detection operates.

In linked mode, each interrupt must be serviced by a host processor before the next interrupt is enabled.

The flowchart in Figure 32 illustrates linked mode operation.

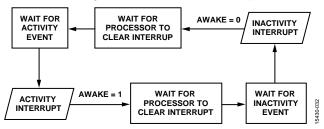


Figure 32. Flowchart Illustrating Activity and Inactivity Operation in Linked Mode

#### Loop Mode

In loop mode, motion detection operates as described in the Linked Mode section, but interrupts do not need to be serviced by a host processor. This configuration simplifies the implementation of commonly used motion detection and enhances power savings by reducing the amount of power used in bus communication.

The flowchart in Figure 33 illustrates loop mode operation.

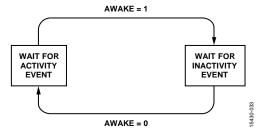


Figure 33. Flowchart Illustrating Activity and Inactivity Operation in Loop Mode

#### Autosleep

If autosleep is selected, after the device is placed in wake-up mode (see the Wake-Up Mode section), it automatically sets to loop mode and begins looking for activity. When activity is detected, the device automatically enters measurement mode and immediately begins looking for inactivity. When inactivity is detected, the device automatically re-enters wake-up mode. Note that the device must be manually placed in wake-up mode before autosleep can begin functioning. It does not automatically enter wake-up mode if the device is started up manually in measurement mode.

#### Using the AWAKE Bit

The AWAKE bit is a status bit that indicates whether the ADXL372 is awake or asleep. In default mode or autosleep mode, the AWAKE bit is high whenever the device is in measurement mode. In linked or loop mode, the AWAKE bit is high whenever the device experiences an activity condition, and it is low when the device experiences an inactivity condition.

The awake signal can be mapped to the INT1 or the INT2 pin allowing the pin to serve as a status output to connect or disconnect power to downstream circuitry based on the awake status of the accelerometer. Used in conjunction with loop mode, this configuration implements a simple, autonomous motion activated switch.

If the turn-on time of downstream circuitry can be tolerated, this motion switch configuration can save significant system level power by eliminating the standby current consumption of the remainder of the application circuit. This standby current can often exceed the full operating current of the ADXL372.

#### **MOTION WARNING**

In addition to the activity threshold previously described, the ADXL372 offers a secondary threshold. This second threshold, the motion warning threshold, can be set independently of the activity threshold. It does not have any functionality related to autosleep, linked, or loop mode, or the device awake status. The purpose of the motion warning functionality is to issue a notification to the system, via the status bit and/or interrupt, that the observed acceleration has exceeded the second threshold. It is controlled by the THRESH\_ACT2\_x\_x registers, and by the ACTIVITY2 interrupt, which is sent only to the INT2 pin. Each axis has its own motion warning threshold. However, the motion warning activity interrupt does not have an activity timer. It is only used for single sample, activity detection. The motion warning threshold also shares the same referenced vs. absolute configuration as the primary activity detection.

#### IMPACT DETECTION FEATURES

Impact detection applications often require high *g* and high bandwidth acceleration measurements, and the ADXL372 is designed with these applications in mind. Several features are included that target impact detection and aim to simplify the system design.

#### **WIDE BANDWIDTH**

An impact is a transient event that produces an acceleration pulse with frequency content over a wide range. A sufficiently wide bandwidth is needed to capture the impact event because lowering bandwidth has the effect of reducing the magnitude of the recorded signal, resulting in measurement inaccuracy.

The ADXL372 can operate with bandwidths of up to 3200 Hz at extremely low power levels. A steep filter roll-off is also useful for effective suppression of out of band content, and the ADXL372 incorporates a four-pole, low-pass antialiasing filter for this purpose.

#### INSTANT ON IMPACT DETECTION

The ADXL372 instant on mode is an ultralow power mode that continuously monitors the environment for impact events that exceed a built in threshold. When an impact is detected, the device switches into full measurement mode and captures the impact profile.

User must enter instant on mode from full bandwidth measurement mode with 16 ms delay before the first valid data gets ready. No digital data is available in this mode of operation. The user can configure the device to detect an impact between a threshold level of either 10 g to 15 g or 30 g to 40 g by using the INSTANT\_ON\_ THRESH bit in the POWER\_CTL register. When an impact beyond the selected threshold is detected, the ADXL372 switches to full bandwidth measurement mode and begins outputting digital data.

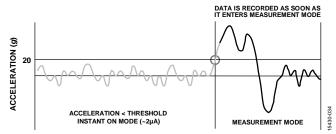


Figure 34. Instant On Mode Using Default Threshold

After the accelerometer is in full bandwidth measurement mode, it must be set back into instant on mode manually. It cannot return to instant on mode automatically.

#### **CAPTURING IMPACT EVENTS**

In certain applications, a single (3-axis) acceleration sample at the peak of an impact event contains sufficient information about the event, and the full acceleration history is not required. For these applications, the ADXL372 provides the capability to store only the peak acceleration of each over threshold event. The x, y, and z acceleration samples at the peak of the event can be stored in the FIFO. Applications that do not require the full event profile can greatly increase the time between FIFO reads by storing only peak acceleration information. A peak is defined as the x, y, and z acceleration sample that has the highest magnitude (root sum squared) of all other values within a particular over threshold event. In addition to recording the peak of each over threshold impact event in the FIFO, the ADXL372 can also keep track of the absolute highest peak recorded in separate registers.

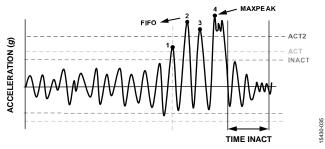


Figure 35. Capturing Impact Events

Enable peak detection by doing the following:

- Put the FIFO in peak detect and stream mode (b0011101x to Register 0x3A).
- Set the desired activity threshold and time settings (Register 0x23 to Register 0x29).
- Set the desired inactivity threshold and time settings (Register 0x2A to Register 0x31).
- Set the activity mode to linked or loop mode (Register 0x3E).

As soon as the activity interrupt is triggered, the device records the x, y, and z values of the peak acceleration event that occurs between the activity interrupt trigger and the next inactivity interrupt trigger, as shown in Figure 35 in the FIFO. It continues to do this for each period of activity between the triggering of the activity interrupt and consequent triggering of the inactivity interrupt. The process does work in linked mode, but the user must be clear each interrupt before the device looks for the next activity or inactivity interrupt. For as long as peak detect mode is selected, the device also stores the highest overall peak recorded in the MAXPEAK\_x\_x registers. When these values are read out of the registers, the register data is cleared, and the device begins looking for the new highest peak.

#### **FIFO**

The ADXL372 includes a deep, 512 sample FIFO buffer.

#### **BENEFITS OF THE FIFO**

The FIFO buffer is an important feature in ultralow power applications in two ways: system level power savings and data recording/event context.

#### System Level Power Savings

Appropriate use of the FIFO enables system level power savings by enabling the host processor to sleep for extended periods while the accelerometer autonomously collects data. Alternatively, using the FIFO to collect data can unburden the host while it tends to other tasks.

#### **Data Recording/Event Context**

The FIFO can be used in a triggered mode to record all data leading up to an activity detection event, thereby providing context for the event. In the case of a system that identifies impact events, for example, the accelerometer can keep the entire system off while it stores acceleration data in its FIFO and looks for an activity event. When the impact event occurs, data collected prior to the event is frozen in the FIFO. The accelerometer can now wake the rest of the system and transfer this data to the host processor, thereby providing context for the impact event.

Generally, the more context available, the more intelligent decisions a system can achieve, making a deep FIFO especially useful. For example, the ADXL372 FIFO can store up to 512 1-axis samples at 400 Hz ODR, providing a 1.28 sec window, or 170 3-axis samples at 3200 Hz to provide a 50 ms window, which is a typical duration for impact events.

#### **USING THE FIFO**

The FIFO is a 512 sample memory buffer that can save power, unburden the host processor, and autonomously record data.

FIFO operation is configured via Register 0x39 and Register 0x3A. The 512 FIFO samples can be allotted in several ways, such as the following:

- 170 sample sets of concurrent 3-axis data
- 256 sample sets of concurrent 2-axis data (user selectable)
- 512 sample sets of single-axis data
- 170 sets of impact event peak (x, y, z)

All FIFO modes must be configured while in standby mode. When reading data from multiple axes from the FIFO, to ensure that data is not overwritten and stored out of order, at least one sample set must be left in the FIFO after every read (therefore, a set of 3-axis data must have 169 samples at most).

The FIFO operates in one of the following four modes: FIFO disabled, oldest saved mode (first N), stream mode (last N), and triggered mode.

#### FIFO Disabled

When the FIFO is disabled, no new data is stored in it, and any data already in it is cleared.

The FIFO is disabled by setting the FIFO\_MODE bits in the FIFO\_CTL register (Register 0x3A) to 0b00.

#### Oldest Saved Mode (First N)

In oldest saved mode, the FIFO accumulates data until it is full and then stops. After reading the data, the FIFO must be disabled and re-enabled to save a new set of data. One possible use case for this mode is to enable it right after entering instant on mode. After a shock is detected, the data immediately stores in the FIFO to be read whenever convenient.

The FIFO is placed into oldest saved mode by setting the FIFO\_MODE bits in the FIFO\_CTL register (Register 0x3A) to 0b11

#### Stream Mode (Last N)

In stream mode, the FIFO always contains the most recent data. The oldest sample is discarded when space is needed to make room for a newer sample.

Stream mode is useful for unburdening a host processor. The processor can tend to other tasks while data is being collected in the FIFO. When the FIFO fills to a certain number of samples (specified by the FIFO\_SAMPLES register along with Bit 0 in the FIFO\_CTL register), it triggers a watermark interrupt (if this interrupt is enabled). At this point, the host processor can read the contents of the entire FIFO and then return to its other tasks as the FIFO fills again.

The FIFO is placed into stream mode by setting the FIFO\_MODE bits in the FIFO\_CTL register (Register 0x3A) to 0b01.

#### Triggered Mode

In triggered mode, the FIFO operates as in stream mode until an activity detection event, after which it saves the samples surrounding that event. The operation is similar to a one-time run trigger on an oscilloscope. The number of samples to be saved after the activity event is specified in FIFO\_SAMPLES (Register 0x39[7:0], along with Bit 0 in the FIFO\_CTL register, Register 0x3A). For example if the FIFO\_SAMPLE is set to 12, there are 500 samples before the trigger and 12 after the trigger. The trigger can be reset by clearing the activity interrupt and reading all 512 locations of the FIFO. If this is not complete, future FIFO data reads may contain invalid data. Place the FIFO into triggered mode by setting the FIFO\_MODE bits in the FIFO\_CTL register (Register 0x3A) to 0b10.

#### **RETRIEVING DATA FROM FIFO**

Access FIFO data by reading the FIFO\_DATA register. A multibyte read to this register does not auto-increment the address, and instead continues to pop data from the FIFO. Data is left justified and formatted as shown in Table 10.

When reading data, the most significant byte (Bits[B15:B8]) is read first, followed by the least significant byte (Bits[B7:B0]). Bits[B15:B4] represent the 12-bit, twos complement acceleration data. Bit 0 serves as a series start indicator: only the first data byte of a series contains a 1 in this bit, and the remaining items contain a 0.

**Table 10. FIFO Buffer Data Format** 

B15 (MSB)	B14	B13	B12	B11	B10	B9	B8
				D	ata		
B7	B6	B5	B4	B3	B2	B1	B0
Data			Reserved			Series start indicator	

#### **INTERRUPTS**

Several of the built in functions of the ADXL372 can trigger interrupts to alert the host processor of certain status conditions. The functionality of these interrupts is described in this section.

#### **INTERRUPT PINS**

Interrupts can be mapped to either (or both) of two designated output pins, INT1 and INT2, by setting the appropriate bits in the INT1\_MAP register and INT2\_MAP register, respectively. All functions can be used simultaneously. If multiple interrupts are mapped to one pin, the OR combination of the interrupts determines the status of the pin.

If no functions are mapped to an interrupt pin, that pin is automatically configured to a high impedance (high-Z) state. The pins are also placed in the high-Z state upon a reset.

When a certain status condition is detected, the pin that condition is mapped to is activated. The configuration of the pin is active high by default so when it is activated, the pin goes high. However, this configuration can be switched to active low by setting the INTx\_LOW bit in the appropriate INTx\_MAP register.

The INTx pins can connect to the interrupt input of a host processor where interrupts are responded to with an interrupt routine. Because multiple functions can be mapped to the same pin, the STATUS register can determine which condition caused the interrupt to trigger.

Interrupts are cleared in several of the following ways:

- Reading the STATUS2 register clears ACTIVITY and INACT interrupts. However, if activity detection is operating in default mode, and the activity or inactivity timers are set to 0, the only way to clear the activity or inactivity bits, respectively, is to set the device into standby mode and restart full bandwidth measurement mode.
- Setting the device into standby mode and back into full bandwidth measurement mode clears the ACTIVITY2 interrupt.
- Reading from the data registers clears the DATA\_RDY interrupt.
- Reading enough data from the FIFO buffer so that interrupt conditions are no longer met, and then reading the STATUS register (Register 0x04) clears the FIFO\_RDY, FIFO\_FULL, and FIFO\_OVR interrupts.

Both interrupt pins are push-pull low impedance pins with an output impedance of about 500  $\Omega$  (typical) and digital output specifications as shown in Table 11. Both have bus keepers that hold them to a valid logic state when they are in a high impedance mode.

To prevent interrupts from being falsely triggered during configuration, disable interrupts while their settings, such as thresholds, timings, or other values, are configured.

#### **Alternate Functions**

The INT1 and INT2 pins can be configured for use as input pins instead of for signaling interrupts. INT1 is used as an external clock input when the EXT\_CLK bit in the TIMING register is set. INT2 is used as the trigger input for synchronized sampling when the EXT\_SYNC bit in the TIMING register is set. One or both of these alternate functions can be used concurrently; however, if an interrupt pin is used for its alternate function, it cannot simultaneously be used to signal interrupts.

#### **TYPES OF INTERRUPTS**

#### **Activity and Inactivity Interrupts**

The ACTIVITY bit and INACT bit are set when activity and inactivity are detected, respectively. Detection procedures and criteria are described in the Autonomous Event Detection section.

#### Data Ready Interrupt

The DATA\_RDY bit is set when new valid data is available, and it is cleared when no new data is available.

The DATA\_RDY bit does not set while any of the data registers are being read. If DATA\_RDY = 0 prior to a register read and new data becomes available during the register read, DATA\_RDY remains 0 until the read is complete and only then sets to 1.

If DATA\_RDY = 1 prior to a register read, it is cleared at the start of the register read.

If DATA\_RDY = 1 prior to a register read and new data becomes available during the register read, DATA\_RDY is cleared to 0 at the start of the register read and remains 0 throughout the read. When the read is complete, DATA\_RDY is set to 1.

#### **FIFO Interrupts**

#### FIFO Watermark

The FIFO\_FULL bit is set when the number of samples stored in the FIFO is equal to or exceeds the number specified in FIFO\_SAMPLES (Register 0x39 together with Bit 0 in the FIFO\_CTL register). The FIFO\_FULL bit is cleared automatically when enough samples are read from the FIFO, such that the number of samples remaining is lower than that specified.

If the number of FIFO samples is set to 0, the watermark interrupt is set. To avoid unexpectedly triggering this interrupt, the default value of the FIFO\_SAMPLES register is 0x80.

#### FIFO Ready

The FIFO\_RDY bit is set when there is at least one valid sample available in the FIFO output buffer. This bit is cleared when no valid data is available in the FIFO. In FIFO triggered mode, it is only set after the activity interrupt is detected, and the data surrounding the event is saved in the FIFO.

#### Overrun

The FIFO\_OVR bit is set when the FIFO has overrun or overflowed, such that new data replaces unread data, which may indicate a full FIFO that has not yet been emptied or a clocking error caused by a slow SPI transaction. If the FIFO is configured to oldest saved mode, an overrun event indicates that there is insufficient space available for a new sample.

The FIFO\_OVR bit is cleared when both the contents of the FIFO and the STATUS register are read. It is also cleared when the FIFO is disabled.

Table 11. Interrupt Pin Digital Output

			Limit <sup>1</sup>	
Parameter	Test Conditions	Min	Max	Unit
Digital Output				
Low Level Output Voltage (Vol)	$I_{OL} = 500 \mu A$		$0.2 \times V_{DDI/O}$	V
High Level Output Voltage (Vон)	$I_{OH} = -300  \mu A$	$0.8 \times V_{DDI/O}$		V
Low Level Output Current (IoL)	$V_{OL} = V_{OL, MAX}$	500		μΑ
High Level Output Current (Іон)	$V_{OH} = V_{OH, MIN}$		-300	μΑ
Pin Capacitance	$f_{IN} = 1 \text{ MHz}, V_{IN} = 2.0 \text{ V}$		8	pF
Rise/Fall Time				
Rise Time (t <sub>R</sub> ) <sup>2</sup>	$C_{LOAD} = 150 pF$		210	ns
Fall Time (t <sub>F</sub> ) <sup>3</sup>	$C_{LOAD} = 150 \text{ pF}$		150	ns

 $<sup>^{\</sup>mbox{\tiny 1}}$  Limits based on characterization results, not production tested.

<sup>&</sup>lt;sup>2</sup> Rise time is measured as the transition time from V<sub>OL, MAX</sub> to V<sub>OH, MIN</sub> of the interrupt pin.

<sup>&</sup>lt;sup>3</sup> Fall time is measured as the transition time from V<sub>OH, MIN</sub> to V<sub>OL, MAX</sub> of the interrupt pin.

# ADDITIONAL FEATURES USING AN EXTERNAL CLOCK

When operating at 3200 Hz ODR or lower, the ADXL372 has a built in 307.2 kHz (typical) clock that, by default, serves as the time base for internal operations. At 6400 Hz ODR, this clock speed increases to 614.4 kHz (typical). If desired, an external clock can be provided instead, for either improved clock frequency accuracy or for control of the output data rate. To use an external clock, set the EXT\_CLK bit (Bit 1) in the TIMING register (Register 0x3D) and apply a clock to the INT1 pin.

The external clock can operate at the nominal 307.2 kHz or slower (when using ODR  $\leq$  3200 Hz), or 614.4 kHz or slower (when using ODR = 6400 Hz) to allow the user to achieve any desired output data rate. Lower external clock rates must be used with caution because it may result in aliasing of high frequency signals that may be present in certain applications.

ODR and bandwidth scale proportionally with the clock. The ADXL372 provides a discrete number of options for ODR. ODRs other than those provided are achieved by selecting an appropriate clock frequency. For example, to achieve a 2560 Hz ODR, use the 3200 Hz setting with a clock frequency that is 80% of nominal, or 245.76 kHz. Bandwidth also scales by the same ratio, so if a 400 Hz bandwidth is selected, the resulting bandwidth is 320 Hz.

#### SYNCHRONIZED DATA SAMPLING

For applications that require a precisely timed acceleration measurement, the ADXL372 features an option to synchronize acceleration sampling to an external trigger. The EXT\_SYNC bit in the TIMING register enables this feature. When the EXT\_SYNC bit is set to 1, the INT2 pin automatically reconfigures for use as the sync trigger input.

When external triggering is enabled, it is up to the system designer to ensure that the sampling frequency meets system requirements. Sampling too infrequently causes aliasing. Noise can be lowered by oversampling; however, sampling at too high a frequency may not allow enough time for the accelerometer to process the acceleration data and convert it to valid digital output data.

When the Nyquist criterion is met, signal integrity is maintained. An internal antialiasing filter is available in the ADXL372 and can assist the system designer in maintaining signal integrity. To prevent aliasing, set the filter bandwidth to a frequency no greater than half the sampling rate. For example, when sampling at 1600 Hz, set the filter bandwidth to no higher than 800 Hz.

Because of internal timing requirements, the maximum allowable external trigger frequencies are as follows:

- 1-axis data = 3100 Hz
- 2-axis data = 2700 Hz
- 3-axis data = 2200 Hz

These values are doubled when an ODR rate of 6400 Hz is selected. Additionally, the trigger signal applied to the INT2 pin must meet the following criteria:

- The trigger signal must be active high.
- The pulse width of the trigger signal must be at least 53  $\mu$ s.
- The minimum sampling frequency is set only by system requirements. Samples need not be polled at any minimum rate; however, if samples are polled at a rate lower than the bandwidth set by the antialiasing filter, aliasing may occur.

The EXT\_SYNC is an active high signal. Due to the asynchronous nature of the internal clock and external sync, there may be a one ODR clock cycle difference between consecutive external sync pulses. The external sync sets the ODR of the system. For example, if sending an external sync at a 2 kHz rate, all 3 axes (if enabled) are sampled in that 2 kHz window.

#### **SELF TEST**

The ADXL372 incorporates a pass or fail self test feature that effectively tests its mechanical and electronic systems simultaneously. When the self test function is invoked, an electrostatic force is applied to the mechanical sensor. This electrostatic force moves the mechanical sensing element in the same manner as acceleration, and the acceleration experienced by the device increases because of this force.

#### **Self Test Procedure**

The self test function is enabled via the ST bit in the SELF\_TEST register, Register 0x40. The recommended procedure for using the self test functionality is as follows:

- 1. Place the device into measurement mode.
- 2. Make sure the low-pass activity filter is enabled.
- 3. Assert self test by setting the ST bit in the SELF\_TEST register (Register 0x40).

Read the self test status bits, ST\_DONE and USER\_ST, after approximately 300 ms to check the pass or fail condition.

#### **USER REGISTER PROTECTION**

The ADXL372 includes user register protection for single event upsets (SEUs). An SEU is a change of state caused by ions or electromagnetic radiation striking a sensitive node in a microelectronic device. The state change is a result of the free charge created by ionization in or close to an important node of a logic element (for example, a memory bit). The SEU itself is not considered permanently damaging to transistor or circuit functionality, but can create erroneous register values. The registers protected from SEU are Register 0x20 to Register 0x3F.

Protection is implemented via a 99-bit error correcting (Hamming type) code and detects both single bit and double bit errors. The check bits are recomputed any time a write to any of the protected registers occurs. At any time, if the stored version of the check bits is not in agreement with the current check bit calculation, the ERR\_USER\_REGS status bit is set.

The ERR\_USER\_REGS bit in the STATUS register starts high when set on an unconfigured device and clears upon the first register write.

#### **USER OFFSET TRIMS**

The ADXL372 has a 4-bit offset trim for each axis that allows users to add positive or negative offset to the default static acceleration values and correct any deviations from ideal that may result as a consequence of varying the operating parameters of the device. The offset trims have a full-scale range of about  $\pm 60$  LSB with a trim profile as shown in Figure 36.

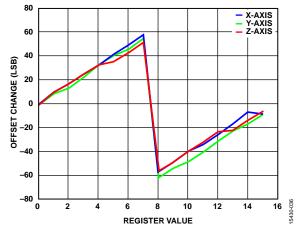


Figure 36. User Offset Trim Profile

# SERIAL COMMUNICATIONS SERIAL INTERFACE

The ADXL372 is designed to communicate in either the SPI or the I<sup>2</sup>C protocol. It autodetects the format being used, requiring no configuration control to select the format.

#### **SPI Protocol**

The timing scheme is as follows: CPHA = CPOL = 0. The ADXL372 supports a SCLK frequency up to 10 MHz. Wire the ADXL372 for SPI communication as shown in Figure 37. For successful communication, follow the logic thresholds and timing parameters in Table 12. The command structure for the read register and write register are shown in Figure 40 and Figure 41, respectively. The read and write register commands support multibyte (burst) read/write access. The waveform diagrams for multibyte read and write commands are shown in Figure 42 and Figure 43, respectively.

Ignore data transmitted from the ADXL372 to the master device during writes to the ADXL372.

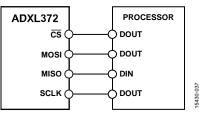


Figure 37. 4-Wire SPI Connection Diagram

#### I<sup>2</sup>C Protocol

The ADXL372 supports point to point I<sup>2</sup>C communication. However, for devices with REVID = 0x02, when sharing an SDA bus, the ADXL372 may prevent communication with other devices on that bus. If at any point, even when the ADXL372 is not being addressed, the 0x3A or 0x3B bytes (when the ADXL372 Device ID is set to 0x1D), or the 0xA6 or 0xA7 bytes (when the ADXL372 Device ID is set to 0x53) are transmitted on the SDA bus, the ADXL372 responds with an acknowledge bit and pulls the SDA line down. For example, this can happen when reading or writing the data bytes to another sensor on the bus. When the ADXL372 pulls the SDA line down, communication with other devices on the bus may be interrupted. To work around this issue, the ADXL372 must be connected to a separate SDA bus, or the SCLK pin must be switched high when communication with the ADXL372 is not desired (it must be normally grounded).

The ADXL372 supports standard (100 kHz), fast (up to 1 MHz), and high speed (up to 3.4 MHz) data transfer modes if the bus parameters given in Table 13 are met. There is no minimum SCL frequency, with the exception that when reading data, the clock must be fast enough to read an entire sample set before new data overwrites it. Single byte or multibyte reads/writes are supported. With the MISO pin low, the I<sup>2</sup>C address for the device is 0x1D, and an alternate I<sup>2</sup>C address of 0x53 can be chosen by pulling the MISO pin high.

There are no internal pull-up or pull-down resistors for any unused pins; therefore, there is no known state or default state for the pins if left floating or unconnected. It is a requirement that SCLK be connected to ground when communicating to the ADXL372 using the I<sup>2</sup>C.

Due to communication speed limitations, the maximum output data rate when using 400 kHz I $^2$ C is 800 Hz and scales linearly with a change in the I $^2$ C communication speed. For example, using I $^2$ C at 100 kHz limits the maximum ODR to 200 Hz. Operation at an output data rate above the recommended maximum can result in undesirable effect on the acceleration data, including missing samples or additional noise.

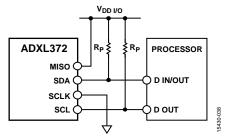


Figure 38.  $I^2C$  Connection Diagram (ADXL372 Device ID = 0x53)

If other devices are connected to the same I²C bus, the nominal operating voltage level of these other devices cannot exceed  $V_{\rm DDI/O}$  by more than 0.3 V. External pull-up resistors,  $R_{\rm P}$ , are necessary for proper I²C operation. Single byte or multibyte reads/writes are supported, as shown from Figure 45 to Figure 47.

#### **MULTIBYTE TRANSFERS**

Both the SPI and  $I^2C$  protocols support multibyte transfers, also known as burst transfers. A register read or write begins with the address specified in the command and auto-increments for each additional byte in the transfer. Always read acceleration data using multibyte transfers to ensure a concurrent and complete set of x-, y-, and z-acceleration data is read.

The FIFO runs on the serial port clock during FIFO reads and can sustain bursting at the SPI clock rate as long as the SPI clock is 1 MHz or faster.

The address auto-increment function is disabled when the FIFO address is used, which is so that data can be read continuously from the FIFO as a multibyte transaction. In cases where the starting address of a multibyte transaction is less than the FIFO address, the address auto-increments until the FIFO address is reached, and then it stops at the FIFO address.

When writing data to the ADXL372 in I<sup>2</sup>C mode, the no acknowledge (NACK) is never generated. Instead, the acknowledge (ACK) bit is sent after every received byte because it is not known how many bytes are included in the transfer. The master decides how many bytes are sent and ends the transaction with the stop condition.

#### **INVALID ADDRESSES AND ADDRESS FOLDING**

The ADXL372 has a 6-bit address bus, mapping only 104 registers in the possible 256 register address space. The addresses do not fold to repeat the registers at addresses above 0x104. Attempted access to register addresses above 0x104 are mapped to the invalid register at 0x67 and have no functional effect.

Register 0x00 to Register 0x42 are for customer access, as described in Table 14. Register 0x43 to Register 0x67 are reserved for factory use.

 $T_A = 25$ °C,  $V_S = 2.5$  V,  $V_{\rm DDI/O} = 2.5$  V, unless otherwise noted.

Table 12. SPI Logic Levels and Timing

Parameter	Description	Min	Тур	Max	Unit
INPUT DC LEVELS					
$V_{IL}$	Low level input voltage			$0.3 \times V_{DDI/O}$	V
$V_{IH}$	High level input voltage	$0.7 \times V_{DDI/O}$			V
I <sub>IL</sub>	Low level input current, $V_{IN} = 0 \text{ V}$	-0.1			μΑ
I <sub>IH</sub>	High level input current, $V_{IN} = V_{DDI/O}$			0.1	μΑ
OUTPUT DC LEVELS					
$V_{OL}$	Low level output voltage, IoL = IoL, MIN			$0.2 \times V_{\text{DDI/O}}$	V
V <sub>OH</sub>	High level output voltage, IoL = IOH, MAX	$0.8 \times V_{DDI/O}$			V
l <sub>OL</sub>	Low level output current, $V_{OL} = V_{OL, MAX}$	-10			mA
I <sub>ОН</sub>	High level output current, Vol = Voh, MIN			4	mA
INPUT AC					
SCLK Frequency		0.1		10	MHz
tніgн	SCLK high time	40			ns
t <sub>LOW</sub>	SCLK low time	40			ns
tcss	CS setup time	20			ns
<b>t</b> <sub>CSH</sub>	CS hold time	20			ns
t <sub>CSD</sub>	CS disable time	40			ns
<b>t</b> sclks	Rising SCLK setup time	20			ns
<b>t</b> su	MOSI setup time	20			ns
t <sub>HD</sub>	MOSI hold time	20			ns
OUTPUT AC					
$t_{P}$	Propagation delay, C <sub>LOAD</sub> = 30 pF			30	ns
t <sub>EN</sub>	Enable MISO time	30			ns
t <sub>DIS</sub>	Disable MISO time			20	ns

#### **SPI Timing Diagrams**

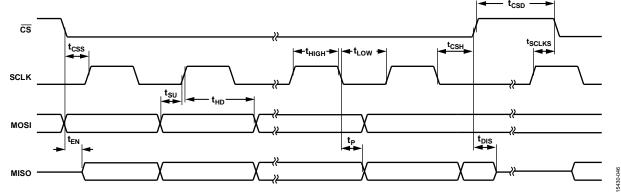


Figure 39. SPI Timing Diagram

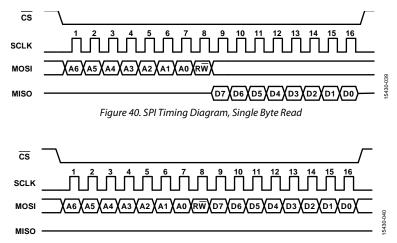


Figure 41. SPI Timing Diagram, Single Byte Write

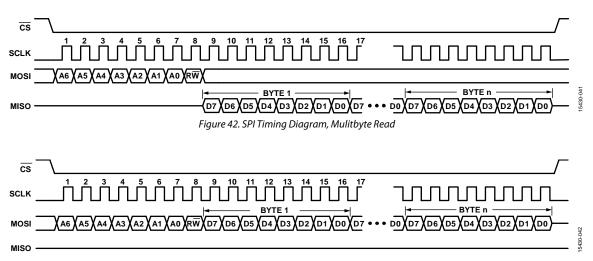


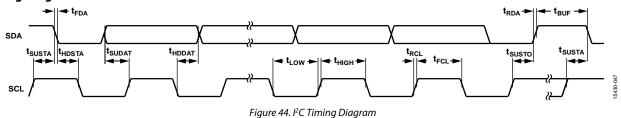
Figure 43. SPI Timing Diagram, Multibyte Write

 $T_A = 25$ °C,  $V_S = 2.5$  V,  $V_{\rm DDI/O} = 1.8$  V, unless otherwise noted.

Table 13. I<sup>2</sup>C Logic Level and Timing

		I2C_HSM	I2C_HSM_EN = 0			_HSM_E	N = 1	
Parameter	Description	Min	Тур	Max	Min	Тур	Max	Unit
INPUT AC								
SCLK Frequency		0		1	0		3.4	MHz
t <sub>HIGH</sub>	SCLK high time	260			120			ns
t <sub>LOW</sub>	SCLK low time	500			320			ns
t <sub>SUSTA</sub>	Start setup time	260			160			ns
<b>t</b> <sub>HDSTA</sub>	Start hold time	260			160			ns
t <sub>SUDAT</sub>	Data setup time	50			10			ns
<b>t</b> <sub>HDDAT</sub>	Data hold time	0			0		150	ns
t <sub>susto</sub>	Stop setup time	260			160			ns
t <sub>BUF</sub>	Bus free time	500						ns
$t_{RCL}$	SCL input rise time			120	20		80	ns
t <sub>FCL</sub>	SCL input fall time	$20 \times (V_{DD}/5.5)$		120	20		80	ns
$t_{RDA}$	SDA input rise time			120	20		160	ns
<b>t</b> <sub>FDA</sub>	SDA input fall time	$20 \times (V_{DD}/5.5)$		120	20		160	ns
OUTPUT AC				•		•		
C <sub>LOAD</sub>				550			400	рF

#### I<sup>2</sup>C Timing Diagrams



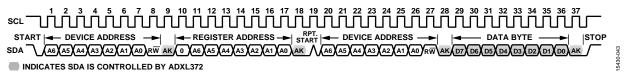


Figure 45. I<sup>2</sup>C Timing Diagram, Single Byte Read



Figure 46. I<sup>2</sup>C Timing Diagram, Single Byte Write

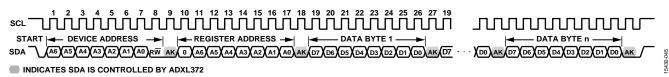


Figure 47. I<sup>2</sup>C Timing Diagram, Multibyte Write

# **REGISTER MAP**

Table 14. Register Map

Reg	Name	Ī	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset	RW
0x00	DEVID_AD	[7:0]			1	DEVID_AD	)				0xAD	R
0x01	DEVID_MST	[7:0]				DEVID_MS	Т				0x1D	R
0x02	PARTID	[7:0]				DEVID_PROD	UCT				0xFA	R
0x03	REVID	[7:0]				REVID					0x03 <sup>1</sup>	R
0x04	STATUS	[7:0]	ERR_USER_ REGS	AWAKE	USER_NVM_BUSY	RESERVED	FIFO_OVR	FIFO_FULL	FIFO_RDY	DATA_RDY	0xA0	R
0x05	STATUS2	[7:0]	RESERVED	ACTIVITY2	ACTIVITY	INACT		RESER	RVED		0x00	R
0x06	FIFO_ENTRIES2	[7:0]			RESERV	VED .			FIFO_ENTRI	ES[9:8]	0x00	R
0x07	FIFO_ENTRIES	[7:0]				FIFO_ENTRIES	[7:0]				0x00	R
0x08	XDATA_H	[7:0]				XDATA[11:	4]				0x00	R
0x09	XDATA_L	[7:0]			XDATA[3:0]			RESER	RVED		0x00	R
0x0A	YDATA_H	[7:0]				YDATA[11:	4]				0x00	R
0x0B	YDATA_L	[7:0]			YDATA[3:0]			RESER	RVED		0x00	R
0x0C	ZDATA_H	[7:0]				ZDATA[11:	4]				0x00	R
0x0D	ZDATA_L	[7:0]			ZDATA[3:0]			RESER	RVED		0x00	R
0x15	MAXPEAK_X_H	[7:0]				MAXPEAK_X[	11:4]				0x00	R
0x16	MAXPEAK_X_L	[7:0]		N	MAXPEAK_X[3:0]			RESER	RVED		0x00	R
0x17	MAXPEAK_Y_H	[7:0]				MAXPEAK_Y[1	11:4]				0x00	R
0x18	MAXPEAK_Y_L	[7:0]		N	MAXPEAK_Y[3:0]			RESER	RVED		0x00	R
0x19	MAXPEAK_Z_H	[7:0]				MAXPEAK_Z[1	11:4]				0x00	R
0x1A	MAXPEAK_Z_L	[7:0]		N	MAXPEAK_Z[3:0]			RESER	RVED		0x00	R
0x20	OFFSET_X	[7:0]		RESERVED				OFFS	ET_X		0x00	R/W
0x21	OFFSET_Y	[7:0]			RESERVED			OFFS	ET_Y		0x00	R/W
0x22	OFFSET_Z	[7:0]			RESERVED			OFFS	ET_Z		0x00	R/W
0x23	THRESH_ACT_X_H	[7:0]				THRESH_ACT_X	([10:3]				0x00	R/W
0x24	THRESH_ACT_X_L	[7:0]		THRESH_A	CT_X[2:0]		RESERVED		ACT_REF	ACT_X_EN	0x00	R/W
0x25	THRESH_ACT_Y_H	[7:0]				THRESH_ACT_Y	/[10:3]				0x00	R/W
0x26	THRESH_ACT_Y_L	[7:0]		THRESH_A	CT_Y[2:0]		RESE	RVED		ACT_Y_EN	0x00	R/W
0x27	THRESH_ACT_Z_H	[7:0]				THRESH_ACT_Z	<u>[10:3]</u>			ll .	0x00	R/W
0x28	THRESH_ACT_Z_L	[7:0]		THRESH_A	CT_Z[2:0]		RESE	RVED		ACT_Z_EN	0x00	R/W
0x29	TIME_ACT	[7:0]				ACT_COUN	IT			ll .	0x00	R/W
0x2A	THRESH_INACT_X_H	[7:0]				THRESH_INACT_	X[10:3]				0x00	R/W
0x2B	THRESH_INACT_X_L	[7:0]		THRESH_IN	ACT_X[2:0]		RESERVED		INACT_REF	INACT_X_EN	0x00	R/W
0x2C	THRESH_INACT_Y_H	[7:0]				THRESH_INACT_	Y[10:3]			ll .	0x00	R/W
0x2D	THRESH_INACT_Y_L	[7:0]		THRESH_IN	ACT_Y[2:0]		RESE	RVED		INACT_Y_EN	0x00	R/W
0x2E	THRESH_INACT_Z_H	[7:0]				THRESH_INACT_	Z[10:3]				0x00	R/W
0x2F	THRESH_INACT_Z_L	[7:0]		THRESH_IN	ACT_Z[2:0]		RESE	RVED		INACT_Z_EN	0x00	R/W
0x30	TIME_INACT_H	[7:0]				INACT_COUNT	[15:8]				0x00	R/W
0x31	TIME_INACT_L	[7:0]				INACT_COUNT	Γ[7:0]				0x00	R/W
0x32	THRESH_ACT2_X_H	[7:0]				THRESH_ACT2_X	X[10:3]				0x00	R/W
0x33	THRESH_ACT2_X_L	[7:0]		THRESH_A	CT2_X[2:0]		RESERVED		ACT2_REF	ACT2_X_EN	0x00	R/W
0x34	THRESH_ACT2_Y_H	[7:0]				THRESH_ACT2_	Y[10:3]		1	I	0x00	R/W
0x35	THRESH_ACT2_Y_L	[7:0]		THRESH_A		_	RESE	RVED		ACT2_Y_EN	0x00	R/W
	THRESH_ACT2_Z_H	[7:0]				THRESH_ACT2_				_ = =		R/W
	THRESH_ACT2_Z_L	[7:0]		THRESH_A			RESE	RVED		ACT2_Z_EN		R/W
		•]	I	3/	= + -4	1		-				

Reg	Name	Bits	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset	RW
0x38	HPF	[7:0]			RESER'	VED		•	HPF_	CORNER	0x00	R/W
0x39	FIFO_SAMPLES	[7:0]				FIFO_SAMPLE	S[7:0]				0x80	R/W
0x3A	FIFO_CTL	[7:0]	RESE	ERVED	FIF	O_FORMAT		FIFO_MODE FIFO_ SAMPLES[8]			0x00	R/W
0x3B	INT1_MAP	[7:0]	INT1_LOW	AWAKE_ INT1	ACT_INT1	INACT_INT1	FIFO_OVR_ INT1	FIFO_FULL_ INT1	FIFO_RDY_ INT1	DATA_RDY_ INT1	0x00	R/W
0x3C	INT2_MAP	[7:0]	INT2_LOW	AWAKE_ INT2	ACT2_INT2	INACT_INT2	FIFO_OVR_ INT2	FIFO_FULL_ INT2	FIFO_RDY_ INT2	DATA_RDY_ INT2	0x00	R/W
0x3D	TIMING	[7:0]		OE	DR .	,	WAKEUP_RATE		EXT_CLK	EXT_SYNC	0x00	R/W
0x3E	MEASURE	[7:0]	USER_OR_ DISABLE	AUTOSLEEP	LINKLOC	)P	LOW_NOISE	BANDWIDTH			0x00	R/W
0x3F	POWER_CTL	[7:0]	I2C_HSM_ EN	RESERVED	INSTANT_ON_THRESH	FILTER_SETTLE	LPF_DISABLE	HPF_DISABLE	М	ODE	0x00	R/W
0x40	SELF_TEST	[7:0]			RESERVED		1	USER_ST	ST_DONE	ST	0x00	R/W
0x41	RESET	[7:0]		RESET					•	0x00	W	
0x42	FIFO_DATA	[7:0]				FIFO_DAT	A				0x00	R

 $<sup>^{\</sup>rm 1}$  The reset value of the REVID register is either 0x03 or 0x02 for the ADXL372.

### **REGISTER DETAILS**

#### **ANALOG DEVICES ID REGISTER**

Address: 0x00, Reset: 0xAD, Name: DEVID\_AD

This register contains the Analog Devices, Inc., ID, 0xAD.

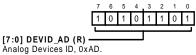


Table 15. Bit Descriptions for DEVID\_AD

Bits	Bit Name	Settings	Description	Reset	Access
[7:0]	DEVID_AD		Analog Devices ID, 0xAD.	0xAD	R

#### **ANALOG DEVICES MEMS ID REGISTER**

Address: 0x01, Reset: 0x1D, Name: DEVID\_MST

This register contains the Analog Devices MEMS ID, 0x1D.

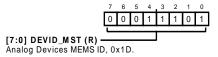


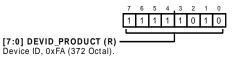
Table 16. Bit Descriptions for DEVID\_MST

Bits	Bit Name Settings		Description	Reset	Access	
[7:0]	DEVID_MST		Analog Devices MEMS ID, 0x1D.	0x1D	R	

#### **DEVICE ID REGISTER**

Address: 0x02, Reset: 0xFA, Name: PARTID

This register contains the device ID, 0xFA (372 octal).



**Table 17. Bit Descriptions for PARTID** 

Bits	Bit Name	Settings	Description	Reset	Access
[7:0]	DEVID_PRODUCT		Device ID, 0xFA (372 Octal).	0xFA	R

#### **PRODUCT REVISION ID REGISTER**

Address: 0x03, Reset: 0x02, Name: REVID

This register contains the mask revision ID, beginning with 0x00 and incrementing for each subsequent revision.

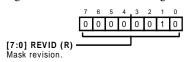


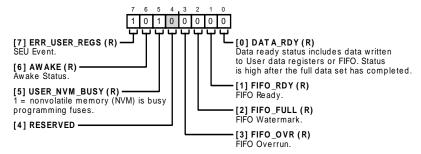
Table 18. Bit Descriptions for REVID

Bits	Bit Name	Settings	Description	Reset	Access
[7:0]	REVID		Mask revision.	0x2	R

#### **STATUS REGISTER**

Address: 0x04, Reset: 0xA0, Name: STATUS

This register includes the following bits that describe various conditions of the ADXL372.



**Table 19. Bit Descriptions for STATUS** 

Bits	Bit Name	Settings	Description	Reset	Access
7	ERR_USER_REGS		SEU Event. An SEU event has been detected in a user register.	0x1	R
6	AWAKE		Awake Status. Activity has been detected and the device is moving.	0x0	R
5	USER_NVM_BUSY		1 = nonvolatile memory (NVM) is busy programming fuses.	0x1	R
4	RESERVED		Reserved.	0x0	R
3	FIFO_OVR		FIFO Overrun. FIFO has overflowed, and data has been lost.	0x0	R
2	FIFO_FULL		FIFO Watermark. The FIFO watermark level, specified in FIFO_SAMPLES, has been reached.	0x0	R
1	FIFO_RDY		FIFO Ready. At least one valid sample is available in the FIFO.	0x0	R
0	DATA_RDY		Data ready status includes data written to user data registers or FIFO. Status is high after the full data set has completed. A complete x, y, and z measurement has been made and results can be read.	0x0	R

#### **ACTIVITY STATUS REGISTER**

Address: 0x05, Reset: 0x00, Name: STATUS2

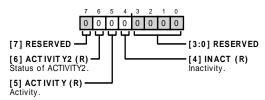


Table 20. Bit Descriptions for STATUS2

Bits	Bit Name	Settings	Description	Reset	Access
7	RESERVED		Reserved.	0x0	R
6	ACTIVITY2		Status of ACTIVITY2.	0x0	R
5	ACTIVITY		Activity. Activity has been detected.	0x0	R
4	INACT		Inactivity. Inactivity has been detected.	0x0	R
[3:0]	RESERVED		Reserved.	0x0	R

#### FIFO ENTRIES REGISTER, MSB

Address: 0x06, Reset: 0x00, Name: FIFO\_ENTRIES2

The FIFO\_ENTRIES2 and FIFO\_ENTRIES registers indicate the number of valid data samples present in the FIFO buffer. The number ranges from 0 to 512 or 0x00 to 0x200. FIFO\_ENTRIES contains the least significant byte, and FIFO\_ENTRIES2 contains the two most significant bits.

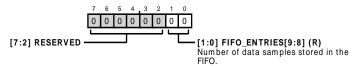


Table 21. Bit Descriptions for FIFO\_ENTRIES2

Bits	Bit Name	Settings	Settings Description F		Access
[7:2]	RESERVED		Reserved.	0x0	R
[1:0]	FIFO_ENTRIES[9:8]		Number of data samples stored in the FIFO.	0x0	R

#### FIFO ENTRIES REGISTER, LSB

Address: 0x07, Reset: 0x00, Name: FIFO\_ENTRIES

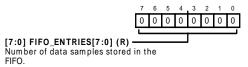


Table 22. Bit Descriptions for FIFO\_ENTRIES

Bits	Bit Name	Settings	Description	Reset	Access
[7:0]	FIFO_ENTRIES[7:0]		Number of data samples stored in the FIFO.	0x0	R

#### X-AXIS DATA REGISTER, MSB

Address: 0x08, Reset: 0x00, Name: XDATA H

These two registers contain the x-axis acceleration data. Data is left justified and formatted as two complement. XDATA\_H contains the eight most significant bits (MSBs), and XDATA\_L contains the four least significant bits (LSBs) of the 12-bit value.

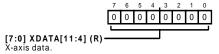


Table 23. Bit Descriptions for XDATA\_H

Bits	Bit Name	Settings	Description	Reset	Access
[7:0]	XDATA[11:4]		X-axis data.	0x0	R

#### X-AXIS DATA REGISTER, LSB

Address: 0x09, Reset: 0x00, Name: XDATA\_L

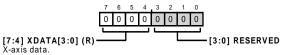


Table 24. Bit descriptions for XDATA\_L

Bits	Bit Name	Settings	Description	Reset	Access
[7:4]	XDATA[3:0]		X-axis data.	0x0	R
[3:0]	RESERVED		Reserved.	0x0	R

#### Y-AXIS DATA REGISTER, MSB

Address: 0x0A, Reset: 0x00, Name: YDATA\_H

The YDATA\_H and YDATA\_L registers contain the y-axis, LSB acceleration data. Data is left justified and formatted as twos complement. YDATA\_H contains the eight most significant bits (MSBs), and YDATA\_L contains the four least significant bits (LSBs) of the 12-bit value.

YDATA\_L latches on a read of YDATA\_H to ensure data integrity.

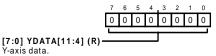


Table 25. Bit Descriptions for YDATA\_H

Bits	Bit Name	Settings	Description	Reset	Access
[7:0]	YDATA[11:4]		Y-axis data.	0x0	R

#### Y-AXIS DATA REGISTER, LSB

Address: 0x0B, Reset: 0x00, Name: YDATA\_L

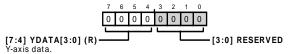


Table 26. Bit Descriptions for YDATA\_L

Bits	Bit Name	Settings	Description	Reset	Access
[7:4]	YDATA[3:0]		Y-axis data.	0x0	R
[3:0]	RESERVED		Reserved.	0x0	R

#### **Z-AXIS DATA REGISTER, MSB**

Address: 0x0C, Reset: 0x00, Name: ZDATA\_H

These two registers contain the z-axis acceleration data. Data is left justified and formatted as two complement. ZDATA\_H contains the eight most significant bits (MSBs), and ZDATA\_L contains the four least significant bits (LSBs) of the 12-bit value.

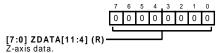


Table 27. Bit Descriptions for ZDATA\_H

Bits	Bit Name	Settings	Description	Reset	Access
[7:0]	ZDATA[11:4]		Z-axis data.	0x0	R

#### **Z-AXIS DATA REGISTER, LSB**

Address: 0x0D, Reset: 0x00, Name: ZDATA\_L

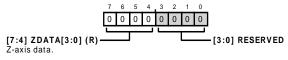


Table 28. Bit Descriptions for ZDATA\_L

Bits	Bit Name	Settings	Description	Reset	Access
[7:4]	ZDATA[3:0]		Z-axis data.	0x0	R
[3:0]	RESERVED		Reserved.	0x0	R

#### **HIGHEST PEAK DATA REGISTERS**

The highest peak data registers contain the acceleration data corresponding to the highest magnitude sample recorded since the last read of this register. Data is left justified and formatted as two complement.

#### X-AXIS HIGHEST PEAK DATA REGISTER, MSB

Address: 0x15, Reset: 0x00, Name: MAXPEAK\_X\_H

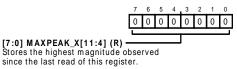
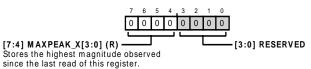


Table 29. Bit Descriptions for MAXPEAK\_X\_H

Bits	Bit Name	Settings	Description	Reset	Access
[7:0]	MAXPEAK_X[11:4]		Stores the highest magnitude observed since the last read of this register. The 8 MSBs of the x-axis value.	0x0	R

#### X-AXIS HIGHEST PEAK DATA REGISTER, LSB

Address: 0x16, Reset: 0x00, Name: MAXPEAK\_X\_L



#### Table 30. Bit Descriptions for MAXPEAK\_X\_L

Bits	Bit Name	Settings	Description	Reset	Access
[7:4]	MAXPEAK_X[3:0]		Stores the highest magnitude observed since the last read of this register. The 4 LSBs of the x-axis value.	0x0	R
[3:0]	RESERVED		Reserved.	0x0	R

#### Y-AXIS HIGHEST PEAK DATA REGISTER, MSB

Address: 0x17, Reset: 0x00, Name: MAXPEAK\_Y\_H

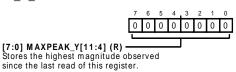


Table 31. Bit Descriptions for MAXPEAK\_Y\_H

Bits	Bit Name	Settings	Description	Reset	Access
[7:0]	MAXPEAK_Y[11:4]		Stores the highest magnitude observed since the last read of this register. The 8 MSBs of the y-axis value.	0x0	R

# Y-AXIS HIGHEST PEAK DATA REGISTER, LSB

Address: 0x18, Reset: 0x00, Name: MAXPEAK\_Y\_L

Table 32. Bit Descriptions for MAXPEAK\_Y\_L

Bits	Bit Name	Settings	Description	Reset	Access
[7:4]	MAXPEAK_Y[3:0]		Stores the highest magnitude observed since the last read of this register. The 4 LSBs of the y-axis value.	0x0	R
[3:0]	RESERVED		Reserved.	0x0	R

# **Z-AXIS HIGHEST PEAK DATA REGISTER, MSB**

Address: 0x19, Reset: 0x00, Name: MAXPEAK\_Z\_H

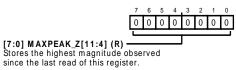
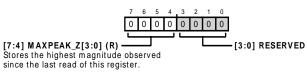


Table 33. Bit Descriptions for MAXPEAK\_Z\_H

Bits	Bit Name	Settings	Description	Reset	Access
[7:0]	MAXPEAK_Z[11:4]		Stores the highest magnitude observed since the last read of this register. The 8 MSBs of the z-axis value.	0x0	R

# **Z-AXIS HIGHEST PEAK DATA REGISTER, LSB**

Address: 0x1A, Reset: 0x00, Name: MAXPEAK\_Z\_L



# Table 34. Bit Descriptions for MAXPEAK\_Z\_L

Bits	Bit Name	Settings	Description	Reset	Access
[7:4]	MAXPEAK_Z[3:0]		Stores the highest magnitude observed since the last read of this register. The 4 LSBs of the z-axis value.	0x0	R
[3:0]	RESERVED		Reserved.	0x0	R

#### **OFFSET TRIM REGISTERS**

Offset trim registers are each four bits and offer user set, offset adjustments in two complement format. The scale factor of these registers is shown in Figure 36.

# X-AXIS OFFSET TRIM REGISTER, LSB

Address: 0x20, Reset: 0x00, Name: OFFSET\_X

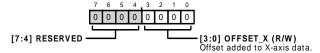


Table 35. Bit Descriptions for OFFSET\_X

Bits	Bit Name	Settings	Description	Reset	Access
[7:4]	RESERVED		Reserved.	0x0	R
[3:0]	OFFSET_X		Offset added to x-axis data.	0x0	R/W

# Y-AXIS OFFSET TRIM REGISTER, LSB

Address: 0x21, Reset: 0x00, Name: OFFSET\_Y

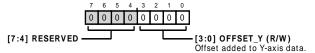


Table 36. Bit Descriptions for OFFSET\_Y

Bits	Bit Name	Settings	Description	Reset	Access
[7:4]	RESERVED		Reserved.	0x0	R
[3:0]	OFFSET_Y		Offset added to y-axis data.	0x0	R/W

# **Z-AXIS OFFSET TRIM REGISTER, LSB**

Address: 0x22, Reset: 0x00, Name: OFFSET\_Z

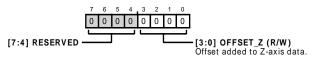


Table 37. Bit Descriptions for OFFSET\_Z

Bits	Bit Name	Settings	Description	Reset	Access
[7:4]	RESERVED		Reserved.	0x0	R
[3:0]	OFFSET_Z		Offset added to z-axis data.	0x0	R/W

# X-AXIS ACTIVITY THRESHOLD REGISTER, MSB

Address: 0x23, Reset: 0x00, Name: THRESH\_ACT\_X\_H

This 11-bit unsigned value sets the threshold for activity detection. This value is set in codes and the scale factor is 100 mg/code. To detect activity, the absolute value of the 12-bit acceleration data is compared with the 11-bit (unsigned) activity threshold value. The THRESH\_ACT\_x\_L register contains the least significant bits and the THRESH\_ACT\_x\_H register contains the most significant byte of the activity threshold value.

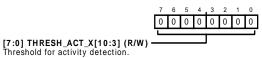


Table 38. Bit Descriptions for THRESH\_ACT\_X\_H

Bits	Bit Name	Settings	Description	Reset	Access
[7:0]	THRESH_ACT_X[10:3]		Threshold for activity detection. The 8 MSBs of x-axis threshold.	0x0	R/W

# X-AXIS OF ACTIVITY THRESHOLD REGISTER, LSB

Address: 0x24, Reset: 0x00, Name: THRESH\_ACT\_X\_L

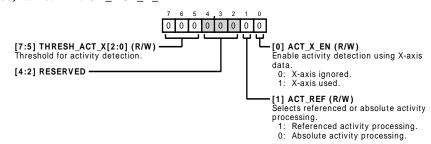


Table 39. Bit Descriptions for THRESH\_ACT\_X\_L

Bits	Bit Name	Settings	Description	Reset	Access
[7:5]	THRESH_ACT_X[2:0]		Threshold for activity detection. The 3 LSBs of x-axis threshold.	0x0	R/W
[4:2]	RESERVED		Reserved.	0x0	R
1	ACT_REF		Selects referenced or absolute activity processing.	0x0	R/W
		1	Referenced activity processing.		
		0	Absolute activity processing.		
0	ACT_X_EN		Enable activity detection using X-axis data.	0x0	R/W
		0	X-axis ignored.		
		1	X-axis used.		

### Y-AXIS ACTIVITY THRESHOLD REGISTER, MSB

Address: 0x25, Reset: 0x00, Name: THRESH\_ACT\_Y\_H



Table 40. Bit Descriptions for THRESH\_ACT\_Y\_H

Bits	Bit Name	Settings	Description	Reset	Access
[7:0]	THRESH_ACT_Y[10:3]		Threshold for activity detection. The 8 MSBs of y-axis threshold.	0x0	R/W

# Y-AXIS OF ACTIVITY THRESHOLD REGISTER, LSB

Address: 0x26, Reset: 0x00, Name: THRESH\_ACT\_Y\_L

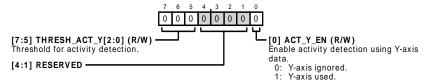


Table 41. Bit Descriptions for THRESH\_ACT\_Y\_L

Bits	Bit Name	Settings	Description	Reset	Access
[7:5]	THRESH_ACT_Y[2:0]		Threshold for activity detection. The 3 LSBs of y-axis threshold.	0x0	R/W
[4:1]	RESERVED		Reserved.	0x0	R
0	ACT_Y_EN		Enable activity detection using y-axis data.	0x0	R/W
		0	Y-axis ignored.		
		1	Y-axis used.		

# **Z-AXIS ACTIVITY THRESHOLD REGISTER, MSB**

Address: 0x27, Reset: 0x00, Name: THRESH\_ACT\_Z\_H

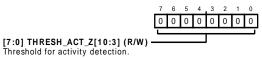


Table 42. Bit Descriptions for THRESH\_ACT\_Z\_H

Bits	Bit Name	Settings	Description	Reset	Access
[7:0]	THRESH_ACT_Z[10:3]		Threshold for activity detection. The 8 MSBs of z-axis threshold.	0x0	R/W

# **Z-AXIS OF ACTIVITY THRESHOLD REGISTER, LSB**

Address: 0x28, Reset: 0x00, Name: THRESH\_ACT\_Z\_L

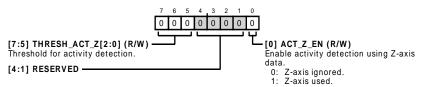


Table 43. Bit Descriptions for THRESH\_ACT\_Z\_L

Bits	Bit Name	Settings	Description	Reset	Access
[7:5]	THRESH_ACT_Z[2:0]		Threshold for activity detection. The 3 LSBs of z-axis threshold.	0x0	R/W
[4:1]	RESERVED		Reserved.	0x0	R
0	ACT_Z_EN		Enable activity detection using Z-axis data.	0x0	R/W
		0	Z-axis ignored.		
		1	Z-axis used.		

#### **ACTIVITY TIME REGISTER**

Address: 0x29, Reset: 0x00, Name: TIME\_ACT

The activity timer implements a robust activity detection that minimizes false positive motion triggers. When the timer is used, only sustained motion can trigger activity detection. The time (in milliseconds) is given by the following equation:

 $Time = TIME\_ACT \times 3.3 \text{ ms per code}$ 

where:

*TIME\_ACT* is the value set in this register.

3.3 ms per code is the scale factor of the TIME\_ACT register for ODR = 6400 Hz. It is 6.6 ms per code for ODR = 3200 Hz and below. See the Activity Timer section for more information.

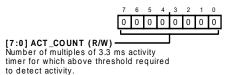


Table 44. Bit Descriptions for TIME\_ACT

Bits	Bit Name	Settings	Description	Reset	Access
[7:0]	ACT_COUNT		Number of multiples of 3.3 ms activity timer for which above threshold acceleration is required to detect activity. It is 3.3 ms per code for 6400 Hz ODR, and it is 6.6 ms per code for 3200 Hz ODR and below.	0x0	R/W

# X-AXIS INACTIVITY THRESHOLD REGISTER, MSB

Address: 0x2A, Reset: 0x00, Name: THRESH\_INACT\_X\_H

This 11-bit unsigned value sets the threshold for inactivity detection. This value is set in codes and the scale factor is 100 mg/code. To detect inactivity, the absolute value of the 12-bit acceleration data is compared with the 11-bit (unsigned) inactivity threshold value. The THRESH\_INACT\_x\_L register contains the least significant bits and the THRESH\_INACT\_x\_H register contains the most significant byte of the inactivity threshold value.



Table 45. Bit Descriptions for THRESH\_INACT\_X\_H

Bits	Bit Name	Settings	Description	Reset	Access
[7:0]	THRESH_INACT_X[10:3]		Threshold for inactivity detection. The 8 MSBs of x-axis.	0x0	R/W

# X-AXIS OF INACTIVITY THRESHOLD REGISTER, LSB

Address: 0x2B, Reset: 0x00, Name: THRESH\_INACT\_X\_L

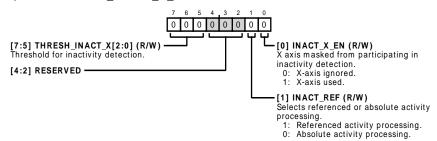


Table 46. Bit Descriptions for THRESH\_INACT\_X\_L

Bits	Bit Name	Settings	Description	Reset	Access
[7:5]	THRESH_INACT_X[2:0]		Threshold for inactivity detection. The 3 LSBs of the x-axis.	0x0	R/W
[4:2]	RESERVED		Reserved.	0x0	R
1	INACT_REF		Selects referenced or absolute inactivity processing.	0x0	R/W
		1	Referenced inactivity processing.		
		0	Absolute inactivity processing.		
0	INACT_X_EN		X-axis masked from participating in inactivity detection.	0x0	R/W
		0	X-axis ignored.		
		1	X-axis used.		

# Y-AXIS INACTIVITY THRESHOLD REGISTER, MSB

Address: 0x2C, Reset: 0x00, Name: THRESH\_INACT\_Y\_H



Table 47. Bit Descriptions for THRESH\_INACT\_Y\_H

Bits	Bit Name	Settings	Description	Reset	Access
[7:0]	THRESH_INACT_Y[10:3]		Threshold for inactivity detection. The 8 MSBs of the y-axis.	0x0	R/W

# Y-AXIS OF INACTIVITY THRESHOLD REGISTER, LSB

Address: 0x2D, Reset: 0x00, Name: THRESH\_INACT\_Y\_L

[7:5] THRESH\_INACT\_Y[2:0] (R/W)
Threshold for inactivity detection.

[4:1] RESERVED

| Threshold for inactivity detection. | (1) | (1) | (2) | (2) | (3) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (4) | (

Table 48. Bit Descriptions for THRESH\_INACT\_Y\_L

Bits	Bit Name	Settings	Description	Reset	Access
[7:5]	THRESH_INACT_Y[2:0]		Threshold for inactivity detection. The 3 LSBs of the y-axis.	0x0	R/W
[4:1]	RESERVED		Reserved.	0x0	R
0	INACT_Y_EN		Y-axis masked from participating in inactivity detection.	0x0	R/W
		0	Y-axis ignored.		
		1	Y-axis used.		

# **Z-AXIS INACTIVITY THRESHOLD REGISTER, MSB**

Address: 0x2E, Reset: 0x00, Name: THRESH\_INACT\_Z\_H

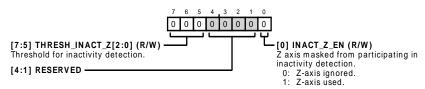


Table 49. Bit Descriptions for THRESH\_INACT\_Z\_H

Bits	Bit Name	Settings	Description	Reset	Access
[7:0]	THRESH_INACT_Z[10:3]		Threshold for inactivity detection. The 8 MSBs of the z-axis.	0x0	R/W

# **Z-AXIS OF INACTIVITY THRESHOLD REGISTER, LSB**

Address: 0x2F, Reset: 0x00, Name: THRESH\_INACT\_Z\_L



#### Table 50. Bit Descriptions for THRESH\_INACT\_Z\_L

Bits	Bit Name	Settings	Description	Reset	Access
[7:5]	THRESH_INACT_Z[2:0]		Threshold for inactivity detection. The 3 LSBs of the z-axis.	0x0	R/W
[4:1]	RESERVED		Reserved.	0x0	R
0	INACT_Z_EN		Z-axis masked from participating in inactivity detection.	0x0	R/W
		0	Z-axis ignored.		
		1	Z-axis used.		

#### **INACTIVITY TIME REGISTERS**

The 16-bit value in these registers sets the time that all enabled axes must be lower than the inactivity threshold for an inactivity event to be detected. The TIME\_INACT\_L register holds the eight LSBs, and the TIME\_INACT\_H register holds the eight MSBs of the 16-bit TIME\_INACT value.

Calculate the time as follows:

 $Time = TIME\_INACT \times 26 \text{ ms per code}$ 

#### where:

TIME\_INACT is the 16-bit value set by the TIME\_INACT\_L register (eight LSBs) and the TIME\_INACT\_H register (eight MSBs). 26 ms per code is the scale factor of the TIME\_INACT\_L and TIME\_INACT\_H registers for 3200 Hz and below. It is 13 ms per code of ODR = 6400 Hz. See the Inactivity Timer section for more information.

#### **INACTIVITY TIMER REGISTER, MSB**

Address: 0x30, Reset: 0x00, Name: TIME\_INACT\_H

0 0 0 0 0 0 0 0

[7:0] INACT\_COUNT[15:8] (R/W) — Number of multiples of 26 ms inactivity timer for which below threshold required to detect inactivity.

Table 51. Bit Descriptions for TIME\_INACT\_H

Bits	Bit Name	Settings	Description	Reset	Access
[7:0]	INACT_COUNT[15:8]		Number of multiples of 26 ms inactivity timer for which below threshold acceleration is required to detect inactivity. It is 26 ms per code for 3200 Hz ODR and below, and it is 13 ms per code for 6400 Hz ODR.	0x0	R/W

# **INACTIVITY TIMER REGISTER, LSB**

Address: 0x31, Reset: 0x00, Name: TIME\_INACT\_L

0 0 0 0 0 0 0 0

[7:0] INACT\_COUNT[7:0] (R/W) Number of multiples of 26 ms inactivity timer for which below threshold required

to detect inactivity.

# Table 52. Bit Descriptions for TIME INACT L

Bits	Bit Name	Settings	Description	Reset	Access
[7:0]	INACT_COUNT[7:0]		Number of multiples of 26 ms inactivity timer for which below threshold acceleration is required to detect inactivity.	0x0	R/W

# X-AXIS MOTION WARNING THRESHOLD REGISTER, MSB

Address: 0x32, Reset: 0x00, Name: THRESH\_ACT2\_X\_H

This 11-bit unsigned value sets the threshold for motion detection. This value is set in codes and the scale factor is 100 mg/code. To detect motion, the absolute value of the 12-bit acceleration data is compared with the 11-bit (unsigned) ACTIVITY2 threshold value. The THRESH\_ACT2\_x\_L register contains the least significant bits and the THRESH\_ACT2\_x\_H register contains the most significant byte of the ACTIVITY2 threshold value.



Table 53. Bit Descriptions for THRESH\_ACT2\_X\_H

Bits	Bit Name	Settings	Description <sup>1</sup>	Reset	Access
[7:0]	THRESH_ACT2_X[10:3]		OTN Threshold. The 8 MSBs of the x-axis threshold for motion warning interrupt.	0x0	R/W

<sup>&</sup>lt;sup>1</sup> OTN stands for other threshold notification.

# X-AXIS OF MOTION WARNING NOTIFICATION REGISTER, LSB

Address: 0x33, Reset: 0x00, Name: THRESH\_ACT2\_X\_L

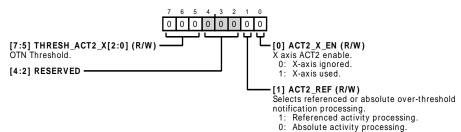


Table 54. Bit Descriptions for THRESH\_ACT2\_X\_L

Bits	Bit Name	Settings	Description <sup>1</sup>	Reset	Access
[7:5]	THRESH_ACT2_X[2:0]		OTN Threshold. The 3 LSBs of the x-axis threshold for motion warning interrupt.	0x0	R/W
[4:2]	RESERVED		Reserved.	0x0	R
1	ACT2_REF		Selects referenced or absolute motion warning notification processing.	0x0	R/W
		1	Referenced activity processing.		
		0	Absolute activity processing.		
0	ACT2_X_EN		X-axis ACT2 enable. When set to 1, the x-axis participates in motion warning notification detection.	0x0	R/W
		0	X-axis ignored.		
		1	X-axis used.		

<sup>&</sup>lt;sup>1</sup> OTN stands for other threshold notification, and ACT2 stands for ACTIVITY2.

# Y-AXIS MOTION WARNING NOTIFICATION THRESHOLD REGISTER, MSB

Address: 0x34, Reset: 0x00, Name: THRESH\_ACT2\_Y\_H

Table 55. Bit Descriptions for THRESH\_ACT2\_Y\_H

Bits	Bit Name	Settings	Description <sup>1</sup>	Reset	Access
[7:0]	THRESH_ACT2_Y[10:3]		OTN Threshold. The 8 MSBs of the y-axis threshold for motion warning interrupt.	0x0	R/W

<sup>&</sup>lt;sup>1</sup> OTN stands for other threshold notification.

# Y-AXIS OF MOTION WARNING NOTIFICATION REGISTER, LSB

Address: 0x35, Reset: 0x00, Name: THRESH\_ACT2\_Y\_L

Table 56. Bit Descriptions for THRESH\_ACT2\_Y\_L

Bits	Bit Name	Settings	Description <sup>1</sup>	Reset	Access
[7:5]	THRESH_ACT2_Y[2:0]		OTN Threshold. The 3 LSBs of the y-axis threshold for motion warning interrupt.	0x0	R/W
[4:1]	RESERVED		Reserved. 0x		R
0	ACT2_Y_EN		Y-axis ACT2 enable. When 1, the y-axis participates in motion warning notification detection.		R/W
	0 Y-axis ignored.		Y-axis ignored.		
		1	Y-axis used.		

<sup>&</sup>lt;sup>1</sup> OTN stands for other threshold notification, and ACT2 stands for ACTIVITY2.

#### **Z-AXIS MOTION WARNING NOTIFICATION THRESHOLD REGISTER, MSB**

Address: 0x36, Reset: 0x00, Name: THRESH\_ACT2\_Z\_H

Table 57. Bit Descriptions for THRESH\_ACT2\_Z\_H

Bits	Bit Name	Settings	Description <sup>1</sup>		Access
[7:0]	THRESH_ACT2_Z[10:3]		$OTNThreshold. The8MSBsofthez\hbox{-axis threshold for motion warning interrupt.}$	0x0	R/W

<sup>&</sup>lt;sup>1</sup> OTN stands for other threshold notification.

# **Z-AXIS MOTION WARNING NOTIFICATION REGISTER, LSB**

Address: 0x37, Reset: 0x00, Name: THRESH\_ACT2\_Z\_L

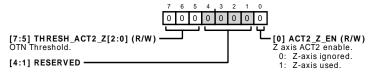


Table 58. Bit Descriptions for THRESH\_ACT2\_Z\_L

Bits	Bit Name	Settings	Description <sup>1</sup>	Reset	Access
[7:5]	THRESH_ACT2_Z[2:0]		OTN Threshold. The 3 LSBs of the z-axis threshold for motion warning interrupt.	0x0	R/W
[4:1]	RESERVED		Reserved.	0x0	R
0	ACT2_Z_EN		Z-axis ACT2 enable. When 1, the z-axis participates in motion warning notification detection.	0x0	R/W
	0		Z-axis ignored.		
		1	Z-axis used.		

<sup>&</sup>lt;sup>1</sup> OTN stands for other threshold notification, and ACT2 stands for ACTIVITY2.

# **HIGH-PASS FILTER SETTINGS REGISTER**

Address: 0x38, Reset: 0x00, Name: HPF

Use this register to specify parameters for the internal high-pass filter.

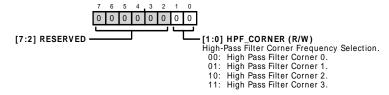


Table 59. Bit Descriptions for HPF

Bits	Bit Name	Settings	Description	Reset	Access
[7:2]	RESERVED		Reserved.	0x0	R
[1:0]	HPF_CORNER		High-Pass Filter Corner Frequency Selection.	0x0	R/W
		00	High Pass Filter Corner 0. At ODR 6400 Hz = $30.48$ Hz, at ODR $3200$ Hz = $15.24$ Hz, at ODR $1600$ Hz = $7.61$ Hz, at ODR $800$ Hz = $3.81$ Hz, and at ODR $400$ Hz = $1.90$ Hz.		
		01	High Pass Filter Corner 1. At ODR 6400 Hz = 15.58 Hz, at ODR 3200 Hz = 7.79 Hz, at ODR 1600 Hz = 3.89 Hz, at ODR 800 Hz = 1.94 Hz, and at ODR 400 Hz = 0.97 Hz.		
		10	High Pass Filter Corner 2. At ODR 6400 Hz = $7.88$ Hz, at ODR 3200 Hz = $3.94$ Hz, at ODR 1600 Hz = $1.97$ Hz, at ODR 800 Hz = $0.98$ Hz, and at ODR 400 Hz = $0.49$ Hz.		
		11	High Pass Filter Corner 3. At ODR 6400 Hz = $3.96$ Hz, at ODR 3200 Hz = $1.98$ Hz, at ODR 1600 Hz = $0.99$ Hz, at ODR 800 Hz = $0.49$ Hz, and at ODR 400 Hz = $0.24$ Hz.		

#### **FIFO SAMPLES REGISTER**

Address: 0x39, Reset: 0x80, Name: FIFO\_SAMPLES

Use the FIFO\_SAMPLES value to specify the number of samples to store in the FIFO. The 8 least significant bits (LSBs) of the FIFO\_SAMPLES value are stored in this register. The most significant bit (MSB) of the FIFO\_SAMPLES value is Bit 0 of the FIFO\_CTL register.

The default value of this register is 0x80 to avoid triggering the FIFO watermark interrupt (see the FIFO Watermark section for more information). In trigger FIFO mode, FIFO\_SAMPLES program the number of samples to be saved after the trigger is detected.

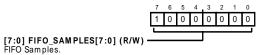


Table 60. Bit Descriptions for FIFO\_SAMPLES

Bits	Bit Name	Settings	Description	Reset	Access
[7:0]	FIFO_SAMPLES[7:0]		FIFO Samples. Watermark number of FIFO samples that triggers a FIFO_FULL condition when reached. Values range from 0 to 512.	0x80	R/W

#### **FIFO CONTROL REGISTER**

Address: 0x3A, Reset: 0x00, Name: FIFO\_CTL

Use this register to specify the operating parameters for the FIFO.

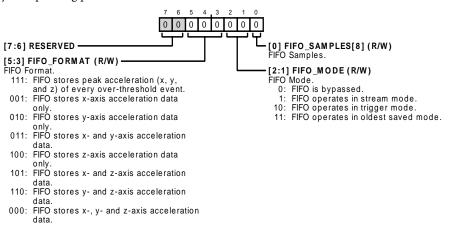


Table 61. Bit Descriptions for FIFO\_CTL

Bits	Bit Name	Settings	Description	Reset	Access
[7:6]	RESERVED		Reserved.	0x0	R
[5:3]	FIFO_FORMAT		FIFO Format. Specifies which data is stored in the FIFO buffer.	0x0	R/W
		111	FIFO stores peak acceleration (x, y, and z) of every over threshold event.		
		001	FIFO stores x-axis acceleration data only.		
		010	FIFO stores y-axis acceleration data only.		
		011	FIFO stores x- and y-axis acceleration data.		
		100	FIFO stores z-axis acceleration data only.		
		101	FIFO stores x- and z-axis acceleration data.		
		110	FIFO stores y- and z-axis acceleration data.		
		000	FIFO stores x-, y- and z-axis acceleration data.		

Bits	Bit Name	Settings	Description	Reset	Access
[2:1]	[2:1] FIFO_MODE		FIFO Mode. Specifies FIFO operating mode.	0x0	R/W
		0	FIFO is bypassed.		
	1 FIFO operates in stream mode.				
		10	FIFO operates in trigger mode.		
		11	FIFO operates in oldest saved mode.		
0			FIFO Samples. Watermark number of FIFO samples that triggers a FIFO_FULL condition when reached. Values range from 0 to 512.	0x0	R/W

### INTERRUPT PIN FUNCTION MAP REGISTERS

Address: 0x3B, Reset: 0x00, Name: INT1\_MAP

The INT1\_MAP and INT2\_MAP registers configure the INT1 and INT2 interrupt pins, respectively. Bits[6:0] select which function(s) generate an interrupt on the pin. If its corresponding bit is set to 1, the function generates an interrupt on the INTx pin. Bit B7 configures whether the pin operates in active high (B7 low) or active low (B7 high) mode. Any number of functions can be selected simultaneously for each pin. If multiple functions are selected, their conditions are OR'ed together to determine the INTx pin state. The status of each function can be determined by reading the status register. If no interrupts are mapped to an INTx pin, the pin remains in a high impedance state.

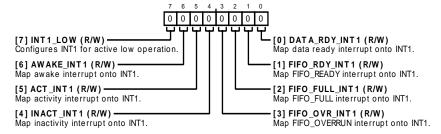


Table 62. Bit Descriptions for INT1\_MAP

Bits	Bit Name	Settings	Description	Reset	Access
7	INT1_LOW		Configures INT1 for active low operation.	0x0	R/W
6	AWAKE_INT1		Map awake interrupt onto INT1.	0x0	R/W
5	ACT_INT1		Map activity interrupt onto INT1.	0x0	R/W
4	INACT_INT1		Map inactivity interrupt onto INT1.	0x0	R/W
3	FIFO_OVR_INT1		Map FIFO_OVERRUN interrupt onto INT1.	0x0	R/W
2	FIFO_FULL_INT1		Map FIFO_FULL interrupt onto INT1.	0x0	R/W
1	FIFO_RDY_INT1		Map FIFO_READY interrupt onto INT1.	0x0	R/W
0	DATA_RDY_INT1		Map data ready interrupt onto INT1.	0x0	R/W

#### **INT2 FUNCTION MAP REGISTER**

Address: 0x3C, Reset: 0x00, Name: INT2\_MAP

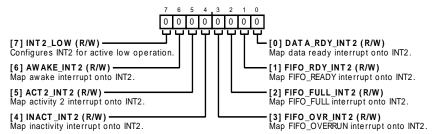


Table 63. Bit Descriptions for INT2\_MAP

Bits	Bit Name	Settings	Description	Reset	Access
7	INT2_LOW		Configures INT2 for active low operation.	0x0	R/W
6	AWAKE_INT2		Map awake interrupt onto INT2.	0x0	R/W
5	ACT2_INT2		Map Activity 2 (motion warning) interrupt onto INT2.	0x0	R/W
4	INACT_INT2		Map inactivity interrupt onto INT2.	0x0	R/W
3	FIFO_OVR_INT2		Map FIFO_OVERRUN interrupt onto INT2.	0x0	R/W
2	FIFO_FULL_INT2		Map FIFO_FULL interrupt onto INT2.	0x0	R/W
1	FIFO_RDY_INT2		Map FIFO_READY interrupt onto INT2.	0x0	R/W
0	DATA_RDY_INT2		Map data ready interrupt onto INT2.	0x0	R/W

# **EXTERNAL TIMING CONTROL REGISTER**

Address: 0x3D, Reset: 0x00, Name: TIMING

Use this register to control the ADXL372 timing parameters: ODR and external timing triggers.

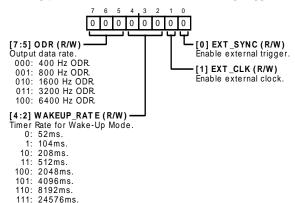


Table 64. Bit Descriptions for TIMING

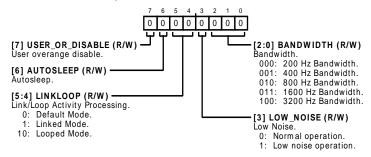
Bits	Bit Name	Settings	Description	Reset	Access
[7:5]	ODR		Output data rate.	0x0	R/W
		000	400 Hz ODR.		
		001	800 Hz ODR.		
		010	1600 Hz ODR.		
		011	3200 Hz ODR.		
		100	6400 Hz ODR.		

Bits	Bit Name	Settings	Description	Reset	Access
[4:2]	WAKEUP_RATE		Timer Rate for Wake-Up Mode.	0x0	R/W
		0	52 ms.		
		1	104 ms.		
		10	208 ms.		
		11	512 ms.		
		100	2048 ms.		
		101	4096 ms.		
		110	8192 ms.		
		111	24576 ms.		
1	EXT_CLK		Enable external clock.	0x0	R/W
0	EXT_SYNC		Enable external trigger.	0x0	R/W

# **MEASUREMENT CONTROL REGISTER**

Address: 0x3E, Reset: 0x00, Name: MEASURE

Use this register to control several measurement settings.



**Table 65. Bit Descriptions for MEASURE** 

Bits	Bit Name	Settings	Description	Reset	Access
7	USER_OR_DISABLE		User overange disable.	0x0	R/W
6	AUTOSLEEP		Autosleep. When set to 1, autosleep is enabled, and the device enters wake-up mode automatically upon detection of inactivity. Activity and inactivity detection must be in linked mode or loop mode (the LINKLOOP bits in the MEASURE register) to enable autosleep; otherwise, the bit is ignored.	0x0	R/W
[5:4]	LINKLOOP		Link/Loop Activity Processing. These bits select how activity and inactivity processing are linked.	0x0	R/W
		0	Default Mode. Activity and inactivity detection, when enabled, operate simultaneously and their interrupts (if mapped) must be acknowledged by the host processor by reading the status register. Autosleep is disabled in this mode.	0x0 R/W	
		1	Linked Mode. Activity and inactivity detection are linked sequentially such that only one is enabled at a time. Their interrupts (if mapped) must be acknowledged by the host processor by reading the status register.		
		10	Looped Mode. Activity and inactivity detection are linked sequentially such that only one is enabled at a time, and their interrupts are internally acknowledged (do not need to be serviced by the host processor). To use either linked or looped mode, both ACT_x_EN and INACT_x_EN must be set to 1; otherwise, the default mode is used. For additional information, refer to the Linking Activity and Inactivity Detection section.		

Bits	Bit Name	Settings	Description		Access
3	LOW_NOISE		Low Noise. Selects low noise operation.	0x0	R/W
		0	nal operation. Device operates at the normal noise level and ultralow ent consumption		
		1	noise operation. Device operates at ~1/3 the normal noise level.		
[2:0]	BANDWIDTH		Bandwidth. Select the desired output signal bandwidth. A 4-pole low-pass filter at the selected frequency limits the signal bandwidth.		R/W
		000	200 Hz Bandwidth.		
		001	400 Hz Bandwidth.		
		010	800 Hz Bandwidth.		
		011	1600 Hz Bandwidth.		
		100	3200 Hz Bandwidth.		

# **POWER CONTROL REGISTER**

Address: 0x3F, Reset: 0x00, Name: POWER\_CTL

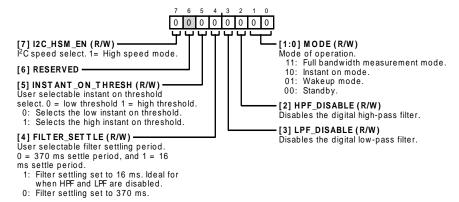


Table 66. Bit Descriptions for POWER\_CTL

Bits	Bit Name	Settings	Description	Reset	Access
7	I2C_HSM_EN		$I^2C$ speed select. 1 = high speed mode.	0x0	R/W
6	RESERVED		erved. 0x		R
5	INSTANT_ON_THRESH		User selectable instant on threshold select. 0 = low threshold, 1 = high threshold.	0x0	R/W
		0	Selects the low instant on threshold.		
		1	Selects the high instant on threshold.		
4	FILTER_SETTLE		er selectable filter settling period. $0 = 370$ ms settle period, and $1 = 16$ ms the period.		R/W
		0	Filter settling set to 370 ms.		
		1	Filter settling set to 16 ms. Ideal for when HPF and LPF are disabled.		
3	LPF_DISABLE		Disables the digital low-pass filter.	0x0	R/W
2	HPF_DISABLE		Disables the digital high-pass filter.	0x0	R/W
[1:0]	MODE		Mode of operation.	0x0	R/W
		11	Full bandwidth measurement mode.		
		10	Instant on mode.		
		01	Wake up mode.		
		00	Standby.		

#### **SELF TEST REGISTER**

Address: 0x40, Reset: 0x00, Name: SELF\_TEST

Refer to the Self Test section for information on the operation of the self test feature, and see the Self Test Procedure section for guidelines on how to use this functionality.

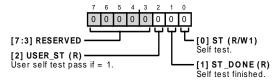


Table 67. Bit Descriptions for SELF\_TEST

Bits	Bit Name	Settings	Description	Reset	Access
[7:3]	RESERVED		Reserved.	0x0	R
2	USER_ST		User self test pass if = 1.	0x0	R
1	ST_DONE		Self test finished.	0x0	R
0	ST		Self test. Writing a 1 to this bit initiates self test. Writing a 0 clears self test.	0x0	R/W1

# **RESET (CLEARS) REGISTER, PART IN STANDBY MODE**

Address: 0x41, Reset: 0x00, Name: RESET

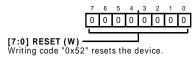


Table 68. Bit Descriptions for RESET

Bits	Bit Name	Settings	Description	Reset	Access
[7:0]	Reset		Writing code 0x52 resets the device.	0x0	W

#### FIFO ACCESS REGISTER

Address: 0x42, Reset: 0x00, Name: FIFO\_DATA

Read this register to access data stored in the FIFO.

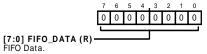


Table 69. Bit Descriptions for FIFO\_DATA

Bits	Bit Name	Settings	Description	Reset	Access
[7:0]	FIFO_DATA		FIFO Data. A read to this address pops a 2-byte word of axis data from the FIFO. FIFO data is formatted to 2 bytes (16 bits), most significant byte first. Two subsequent reads complete the transaction of this data onto the interface. Continued reading of this field continues to pop the FIFO every third read. Multibyte reads to this address do not increment the address pointer. If this address is read due to an auto-increment from the previous address, it does not pop the FIFO. It returns zeros and increment on to the next address.	0x0	R

# APPLICATIONS INFORMATION APPLICATION EXAMPLES

This section includes a few application circuits, highlighting useful features of the ADXL372.

#### **Power Supply Decoupling**

Figure 48 shows the recommended bypass capacitors for use with the ADXL372.

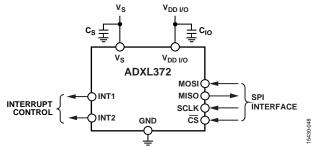


Figure 48. Recommended Bypass Capacitors

A 0.1  $\mu$ F ceramic capacitor ( $C_s$ ) at  $V_s$  and a 0.1  $\mu$ F ceramic capacitor ( $C_{IO}$ ) at  $V_{DDI/O}$  placed as close as possible to the ADXL372 supply pins are recommended to adequately decouple the accelerometer from noise on the power supply. It is recommended that  $V_s$  and  $V_{DDI/O}$  be separate supplies to minimize digital clocking noise on the  $V_s$  supply. If this is not possible, additional filtering of the supplies may be necessary.

If additional decoupling is necessary, a resistor or ferrite bead, no larger than 100  $\Omega,$  in series with  $V_S,$  is recommended. Additionally, increasing the bypass capacitance on  $V_S$  to a 1  $\mu F$  tantalum capacitor in parallel with a 0.1  $\mu F$  ceramic capacitor may also improve noise.

Ensure that the connection from the ADXL372 ground to the power supply ground has low impedance because noise transmitted through ground has an effect similar to noise transmitted through  $V_{\text{S}}$ .

# **Using External Timing Triggers**

Figure 49 shows an application diagram for using the INT1 pin as the input for an external clock. In this mode, the external clock determines all accelerometer timing, including the output data rate and bandwidth.

Set the EXT\_CLK bit in the TIMING register to enable this feature.

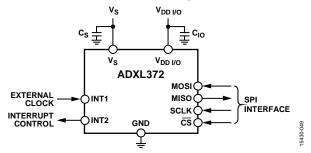


Figure 49. INT1 Pin as Input for External Clock

Figure 50 is an application diagram for using the INT2 pin as a trigger for synchronized sampling. Acceleration samples are produced every time this trigger is activated. Set the EXT\_SYNC bit in the TIMING register to enable this feature.

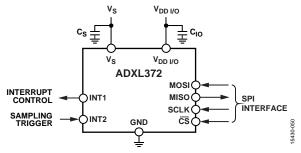


Figure 50. Using the INT2 Pin to Trigger Synchronized Sampling

#### **OPERATION AT VOLTAGES OTHER THAN 2.5 V**

The ADXL372 is tested and specified at a supply voltage of  $V_S$  = 2.5 V; however, it can be powered with a  $V_S$  as high as 3.5 V or as low as 1.6 V. Some performance parameters change as the supply voltage changes, including the supply current, noise, offset, and sensitivity.

# OPERATION AT TEMPERATURES OTHER THAN AMBIENT

The ADXL372 is tested and specified at an ambient temperature; however, it is rated for temperatures between -40°C and +105°C. Some performance parameters change along with temperature, such as offset, sensitivity, clock performance, and current. Some of these temperature variations are characterized in Table 1, and others are shown in the figures within the Typical Performance Characteristics section.

#### MECHANICAL CONSIDERATIONS FOR MOUNTING

Mount the ADXL372 on the PCB in a location close to a hard mounting point of the PCB to the case. Mounting the ADXL372 at an unsupported PCB location, as shown in Figure 51, can result in large, apparent measurement errors due to undamped PCB vibration. Locating the accelerometer near a hard mounting point ensures that any PCB vibration at the accelerometer is above the mechanical sensor resonant frequency of the accelerometer and, therefore, effectively invisible to the accelerometer. Multiple mounting points, close to the sensor, and/or a thicker PCB also help to reduce the effect of system resonance on the performance of the sensor.

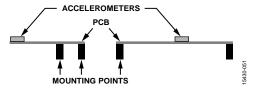


Figure 51. Incorrectly Placed Accelerometers

# **AXES OF ACCELERATION SENSITIVITY**

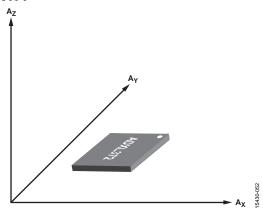


Figure 52. Axes of Acceleration Sensitivity (Corresponding Output Increases When Accelerated Along the Sensitive Axis)

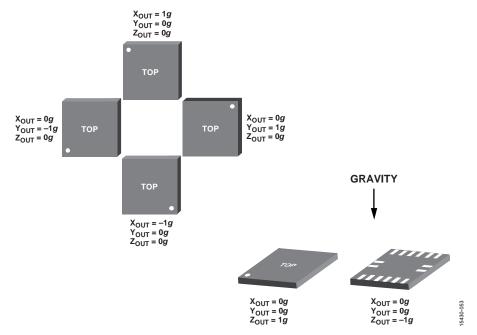


Figure 53. Output Response vs. Orientation to Gravity

# **LAYOUT AND DESIGN RECOMMENDATIONS**

Figure 54 shows the recommended printed wiring board land pattern.

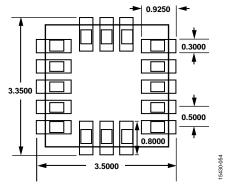


Figure 54. Recommended Printed Wiring Board Land Pattern (Dimensions Shown in Millimeters)

# **OUTLINE DIMENSIONS**

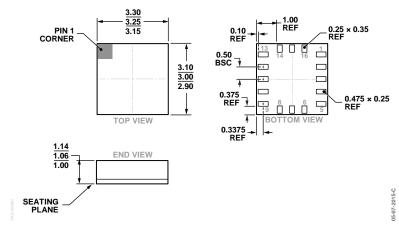


Figure 55. 16-Terminal Land Grid Array [LGA] (CC-16-4) Dimensions shown in millimeters

# **ORDERING GUIDE**

Model <sup>1</sup>	Temperature Range	Package Description	Package Option	Quantity
ADXL372BCCZ-RL	−40°C to +105°C	16-Terminal Land Grid Array [LGA]	CC-16-4	5,000
ADXL372BCCZ-RL7	-40°C to +105°C	16-Terminal Land Grid Array [LGA]	CC-16-4	1,500
EVAL-ADXL372Z	-40°C to +105°C	Breakout Board		

<sup>&</sup>lt;sup>1</sup> Z = RoHS Compliant Part.

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ADXL372BCCZ-RL7 735T 787-500 787AM8 793-6 793L 997-M4 HV101 HV102 HV200 PC420AR-10 PC420VP-50 786A 786A-IS
787A 787A-IS HT786A HT787A PC420VP-10 AD22293Z-RL7 ADIS16003CCCZ ADIS16228CMLZ ADXL700WBRWZ-RL
ADXL1003BCPZ ADXL103CE-REEL ADXL203CE-REEL ADXL206HDZ ADXL213AE ADXL288WBRDZ-RL ADXL295WBRDZ-RL
ADXL312WACPZ